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## Xtrinsic MMA52xxAKW PSI5 Inertial Sensor

The MMA52xxAKW family, a SafeAssure solution, includes the PSI5 Version 1.3 asynchronous mode compatible overdamped X-axis satellite accelerometers.

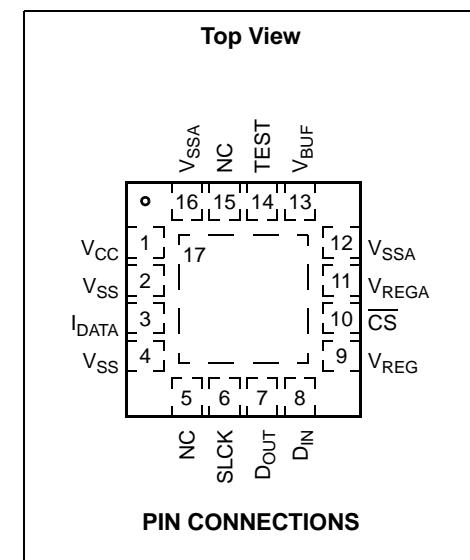
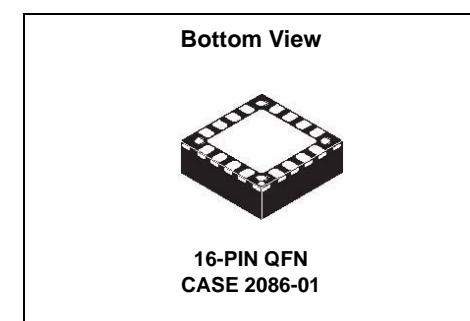
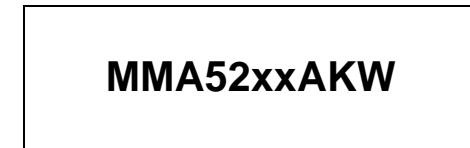
### Features

- $\pm 60g$  to  $\pm 480g$  Full-Scale Range
- 400 Hz, 3-Pole Low-Pass Filter
- Single Pole, High-Pass Filter with Fast Startup and Output Rate Limiting
- PSI5 Version 1.3 Asynchronous Mode Compatible
  - PSI5-A10P-228/1L Compatible
  - Baud Rate: 125 kBaud
  - 10-bit Data
  - Even Parity Error Detection
- 16  $\mu$ s Internal Sample Rate, with Interpolation to 1  $\mu$ s
- Pb-Free 16-Pin QFN, 6 by 6 Package
- Qualified AECQ100, Revision G, Grade 1 (-40°C to +125°C) (<http://www.aecouncil.com/>)

### Typical Applications

- Airbag Front and Side Crash Detection

| ORDERING INFORMATION |      |       |         |             |
|----------------------|------|-------|---------|-------------|
| Device               | Axis | Range | Package | Shipping    |
| MMA5206AKW           | X    | 60g   | 2086-01 | Tubes       |
| MMA5212AKW           | X    | 120g  | 2086-01 | Tubes       |
| MMA5224AKW           | X    | 240g  | 2086-01 | Tubes       |
| MMA5248AKW           | X    | 480g  | 2086-01 | Tubes       |
| MMA5206AKWR2         | X    | 60g   | 2086-01 | Tape & Reel |
| MMA5212AKWR2         | X    | 120g  | 2086-01 | Tape & Reel |
| MMA5224AKWR2         | X    | 240g  | 2086-01 | Tape & Reel |
| MMA5248AKWR2         | X    | 480g  | 2086-01 | Tape & Reel |



## Application Diagram

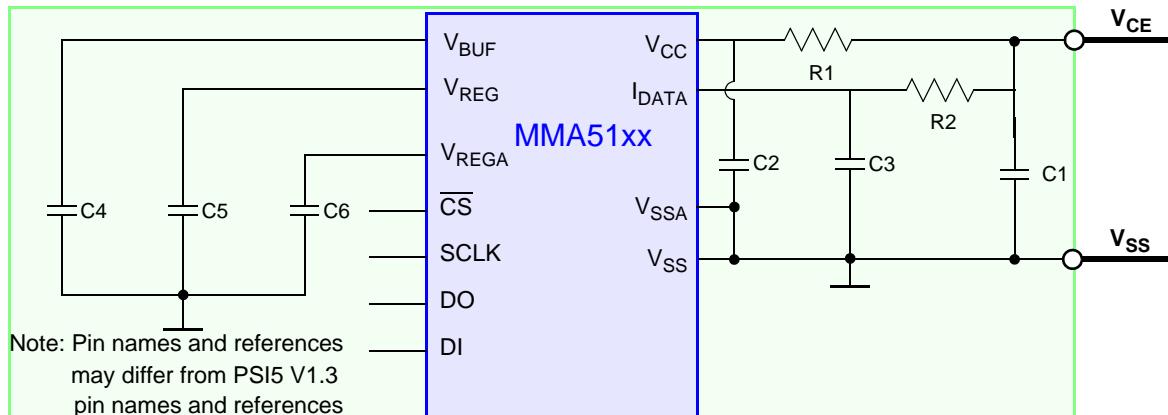


Figure 1. Application Diagram

| External Component Recommendations |                 |                                  |                                                            |
|------------------------------------|-----------------|----------------------------------|------------------------------------------------------------|
| Ref Des                            | Type            | Description                      | Purpose                                                    |
| C1                                 | Ceramic         | 2.2 nF, 10%, 50V minimum, X7R    | V <sub>CC</sub> Power Supply Decoupling and Signal Damping |
| C3                                 | Ceramic         | 470 pF, 10%, 50V minimum, X7R    | I <sub>DATA</sub> Filtering and Signal Damping             |
| C2                                 | Ceramic         | 15 nF, 10%, 50V minimum, X7R     | V <sub>CC</sub> Power Supply Decoupling                    |
| C4, C5, C6                         | Ceramic         | 1 $\mu$ F, 10%, 10V minimum, X7R | Voltage Regulator Output Capacitor(s)                      |
| R1                                 | General Purpose | 82 $\Omega$ , 5%, 200 PPM        | V <sub>CC</sub> Filtering and Signal Damping               |
| R2                                 | General Purpose | 27 $\Omega$ , 5%, 200 PPM        | I <sub>DATA</sub> Filtering and Signal Damping             |

## Device Orientation

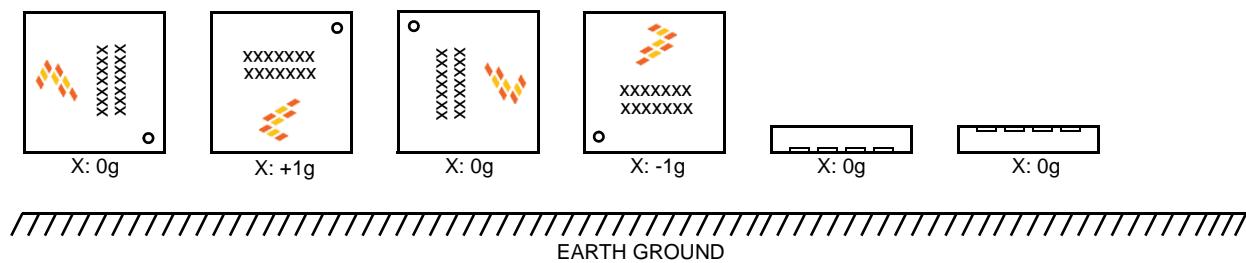


Figure 2. Device Orientation Diagram

## Internal Block Diagram

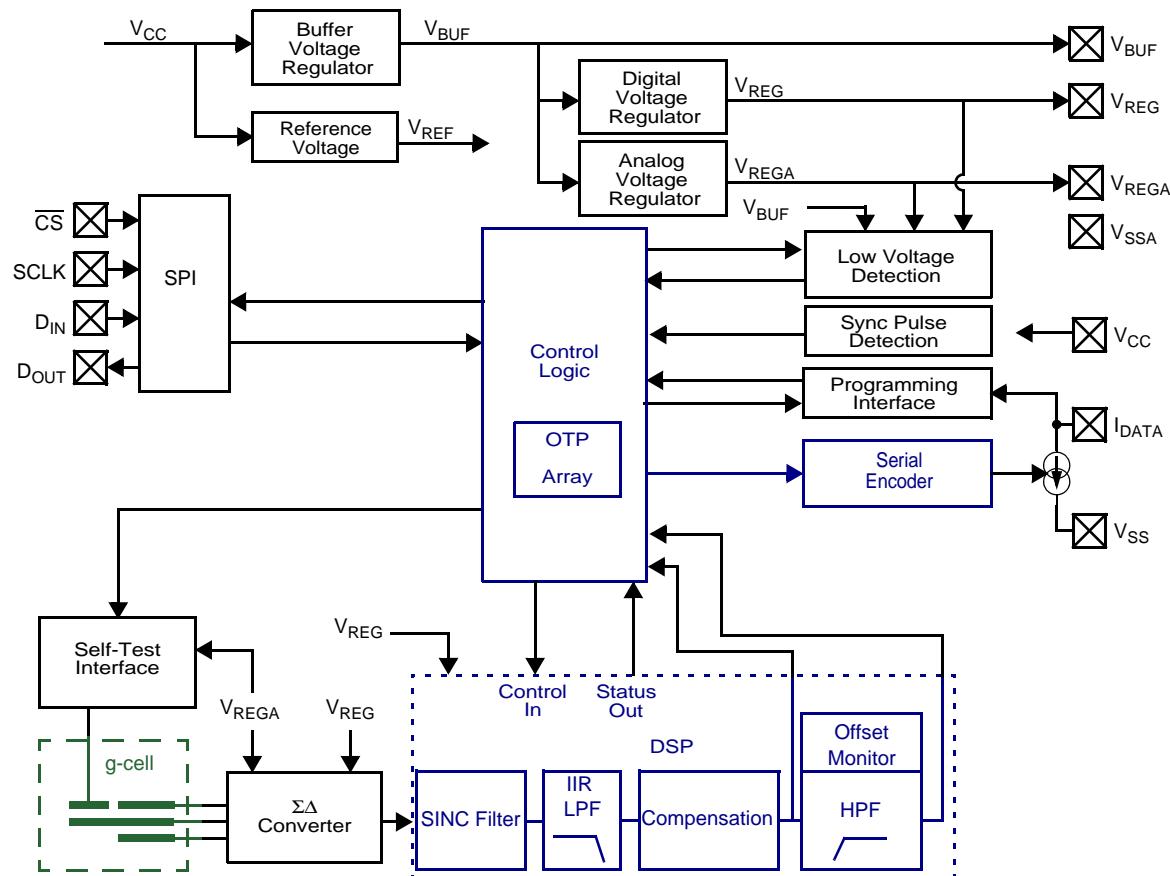


Figure 3. Block Diagram

## 1 Pin Connections

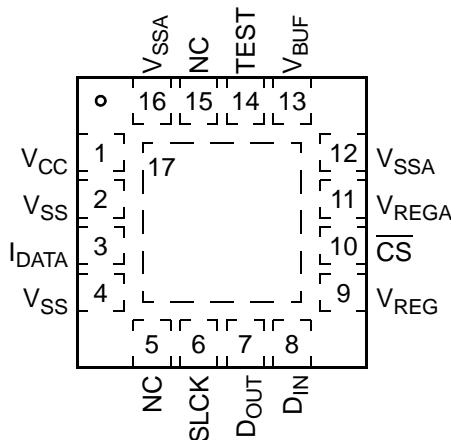


Figure 4. Top View, 16-Pin QFN Package

Table 1. Pin Description

| Pin | Pin Name          | Formal Name      | Definition                                                                                                                                                                                                                                                                                                                                                   |
|-----|-------------------|------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | V <sub>CC</sub>   | Supply           | This pin is connected to the PSI5 power and data line through a resistor and supplies power to the device. An external capacitor must be connected between this pin and V <sub>SS</sub> . Reference Figure 1.                                                                                                                                                |
| 2   | V <sub>SS</sub>   | Digital GND      | This pin is the power supply return node for the digital circuitry.                                                                                                                                                                                                                                                                                          |
| 3   | I <sub>DATA</sub> | Response Current | This pin is connected to the PSI5 power and data line through a resistor and modulates the response current for PSI5 communication. Reference Figure 1.                                                                                                                                                                                                      |
| 4   | V <sub>SS</sub>   | Digital GND      | This pin is the power supply return node for the digital circuitry.                                                                                                                                                                                                                                                                                          |
| 5   | NC                | Not Connected    | This pin must be left unconnected in the application.                                                                                                                                                                                                                                                                                                        |
| 6   | SCLK              | SPI Clock        | This input pin provides the serial clock to the SPI port for test purposes. An internal pulldown device is connected to this pin. This pin must be grounded or left unconnected in the application.                                                                                                                                                          |
| 7   | D <sub>OUT</sub>  | SPI Data Out     | This pin functions as the serial data output from the SPI port for test purposes. This pin must be left unconnected in the application.                                                                                                                                                                                                                      |
| 8   | D <sub>IN</sub>   | SPI Data In      | This pin functions as the serial data input to the SPI port for test purposes. An internal pulldown device is connected to this pin. This pin must be grounded or left unconnected in the application.                                                                                                                                                       |
| 9   | V <sub>REG</sub>  | Digital Supply   | This pin is connected to the power supply for the internal digital circuitry. An external capacitor must be connected between this pin and V <sub>SS</sub> . Reference Figure 1.                                                                                                                                                                             |
| 10  | CS                | Chip Select      | This input pin provides the chip select to the SPI port for test purposes. An internal pullup device is connected to this pin. This pin must be left unconnected in the application.                                                                                                                                                                         |
| 11  | V <sub>REGA</sub> | Analog Supply    | This pin is connected to the power supply for the internal analog circuitry. An external capacitor must be connected between this pin and V <sub>SSA</sub> . Reference Figure 1.                                                                                                                                                                             |
| 12  | V <sub>SSA</sub>  | Analog GND       | This pin is the power supply return node for the analog circuitry.                                                                                                                                                                                                                                                                                           |
| 13  | V <sub>BUF</sub>  | Power Supply     | This pin is connected to a buffer regulator for the internal circuitry. The buffer regulator supplies both the analog (V <sub>REGA</sub> ) and digital (V <sub>REG</sub> ) supplies to provide immunity from EMC and supply dropouts on V <sub>CC</sub> . An external capacitor must be connected between this pin and V <sub>SS</sub> . Reference Figure 1. |
| 14  | TEST              | Test Pin         | This pin is must be grounded or left unconnected in the application.                                                                                                                                                                                                                                                                                         |
| 15  | NC                | Not Connected    | This pin must be left unconnected in the application.                                                                                                                                                                                                                                                                                                        |
| 16  | V <sub>SSA</sub>  | Analog GND       | This pin is the power supply return node for the analog circuitry.                                                                                                                                                                                                                                                                                           |
| 17  | PAD               | Die Attach Pad   | This pin is the die attach flag, and is internally connected to VSS.                                                                                                                                                                                                                                                                                         |
|     | Corner Pads       | Corner Pads      | The corner pads are internally connected to V <sub>SS</sub> .                                                                                                                                                                                                                                                                                                |

## 2 Electrical Characteristics

### 2.1 Maximum Ratings

Maximum ratings are the extreme limits to which the device can be exposed without permanently damaging it.

| #  | Rating                                                                     | Symbol          | Value        | Unit |         |
|----|----------------------------------------------------------------------------|-----------------|--------------|------|---------|
| 1  | Supply Voltage ( $V_{CC}$ , $I_{DATA}$ )                                   | $V_{CC\_REV}$   | -0.7         | V    | (3)     |
| 2  | Reverse Current $\leq 160$ mA, $t \leq 80$ ms                              | $V_{CC\_MAX}$   | +20.0        | V    | (3)     |
| 3  | Continuous                                                                 | $V_{CC\_TRANS}$ | +25.0        | V    | (9)     |
| 4  | Transient (< 10 $\mu$ s)                                                   |                 |              |      |         |
| 4  | $V_{BUF}$ , Test                                                           |                 | -0.3 to +4.2 | V    | (3)     |
| 5  | $V_{REG}$ , $V_{REGA}$ , $SCLK$ , $\overline{CS}$ , $D_{IN}$ , $D_{OUT}$   |                 | -0.3 to +3.0 | V    | (3)     |
| 6  | Powered Shock (six sides, 0.5 ms duration)                                 | $g_{pms}$       | $\pm 2000$   | g    | (3)     |
| 7  | Unpowered Shock (six sides, 0.5 ms duration)                               | $g_{shock}$     | $\pm 2500$   | g    | (3)     |
| 8  | Drop Shock (to concrete, tile or steel surface, 10 drops, any orientation) | $h_{DROP}$      | 1.2          | m    | (5)     |
| 9  | Electrostatic Discharge (per AECQ100)                                      | $V_{ESD}$       | $\pm 4000$   | V    | (5)     |
| 10 | External Pins ( $V_{CC}$ , $I_{DATA}$ , $V_{SS}$ , $V_{SSA}$ )             | $V_{ESD}$       | $\pm 2000$   | V    | (5)     |
| 11 | HBM (100 pF, 1.5 k $\Omega$ )                                              | $V_{ESD}$       | $\pm 1500$   | V    | (5)     |
| 12 | CDM ( $R = 0\Omega$ )                                                      | $V_{ESD}$       | $\pm 200$    | V    | (5)     |
|    | MM (200 pF, 0 $\Omega$ )                                                   |                 |              |      |         |
| 13 | Temperature Range                                                          | $T_{stg}$       | -40 to +125  | °C   | (3)     |
| 14 | Storage                                                                    | $T_J$           | -40 to +150  | °C   | (9)     |
| 15 | Junction                                                                   |                 |              |      |         |
| 15 | Thermal Resistance                                                         | $\theta_{JC}$   | 2.5          | °C/W | (9, 14) |

### 2.2 Operating Range

$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified.

| #  | Characteristic              | Symbol       | Min              | Typ | Max   | Units |     |
|----|-----------------------------|--------------|------------------|-----|-------|-------|-----|
| 16 | Supply Voltage              | $V_{CC}$     | $V_L$            | —   | $V_H$ | V     | (1) |
| 17 |                             | $V_{CC\_UV}$ | 4.2              | —   | 17.0  | V     | (9) |
|    |                             |              | $V_{VCC\_UV\_F}$ |     | $V_L$ | V     |     |
| 18 | Operating Temperature Range | $T_A$        | $T_L$            | —   | $T_H$ | °C    | (1) |
| 19 |                             | $T_A$        | -40              | —   | +105  | °C    | (3) |
|    |                             |              | -40              |     | +125  | °C    |     |

## 2.3 Electrical Characteristics - Supply and I/O

$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified.

| #  | Characteristic                                                            | Symbol               | Min               | Typ               | Max               | Units    |
|----|---------------------------------------------------------------------------|----------------------|-------------------|-------------------|-------------------|----------|
| 20 | Quiescent Supply Current                                                  | $I_{IDLE}$           | 4.0               | —                 | 8.0               | mA       |
| 21 | Modulation Supply Current                                                 | $I_{MOD}$            | $I_{IDLE} + 22.0$ | $I_{IDLE} + 26.0$ | $I_{IDLE} + 30.0$ | mA       |
| 22 | Inrush Current (Power On until $V_{BUF}$ , $V_{REG}$ , $V_{REGA}$ Stable) | $I_{INRUSH}$         | —                 | —                 | 30                | mA       |
| 23 | Internally Regulated Voltages                                             | $V_{BUF}$            | 3.60              | 3.80              | 4.00              | V        |
| 24 |                                                                           | $V_{REG}$            | 2.425             | 2.50              | 2.575             | V        |
| 25 |                                                                           | $V_{REGA}$           | 2.425             | 2.50              | 2.575             | V        |
| 26 | Low Voltage Detection Threshold                                           | $V_{VCC\_UV\_F}$     | 3.40              | 3.70              | 4.0               | V        |
| 27 | $V_{CC}$ Falling                                                          | $V_{BUF\_UV\_F}$     | 2.95              | 3.15              | 3.35              | V        |
| 28 | $V_{BUF}$ Falling                                                         | $V_{REG\_UV\_F}$     | 2.15              | 2.25              | 2.35              | V        |
| 29 | $V_{REG}$ Falling                                                         | $V_{REGA\_UV\_F}$    | 2.15              | 2.25              | 2.35              | V        |
| 30 | Hysteresis                                                                | $V_{CC\_HYST}$       | 0.10              | 0.25              | 0.40              | V        |
| 31 |                                                                           | $V_{BUF\_HYST}$      | 0.05              | 0.10              | 0.15              | V        |
| 32 |                                                                           | $V_{REG\_HYST}$      | 0.05              | 0.10              | 0.15              | V        |
| 33 |                                                                           | $V_{REGA\_HYST}$     | 0.05              | 0.10              | 0.15              | V        |
| 34 | External Capacitor ( $V_{BUF}$ , $V_{REG}$ , $V_{REGA}$ )                 | ESR                  | 500<br>0          | 1000<br>—         | 1500<br>200       | nF<br>mΩ |
| 35 | Capacitance<br>ESR (including interconnect resistance)                    |                      |                   |                   |                   |          |
| 36 | Output High Voltage (DO)<br>$I_{Load} = 100 \mu A$                        | $V_{OH}$             | $V_{REG} - 0.1$   | —                 | —                 | V        |
| 37 | Output Low Voltage (DO)<br>$I_{Load} = 100 \mu A$                         | $V_{OL}$             | —                 | —                 | 0.1               | V        |
| 38 | Input High Voltage<br>CS, SCLK, DI                                        | $V_{IH}$             | $0.7 * V_{REG}$   | —                 | —                 | V        |
| 39 | Input Low Voltage<br>CS, SCLK, DI                                         | $V_{IL}$             | —                 | —                 | $0.3 * V_{REG}$   | V        |
| 40 | Input Current<br>High (at $V_{IH}$ ) (D)<br>Low (at $V_{IL}$ ) (CS)       | $I_{IH}$<br>$I_{IL}$ | -100<br>10        | —                 | -10<br>100        | μA<br>μA |
| 41 |                                                                           |                      |                   |                   |                   |          |
| 42 | Pulldown Resistance (SCLK)                                                | $R_{PD}$             | 20                | æ                 | 100               | kΩ       |

## 2.4 Electrical Characteristics - Sensor and Signal Chain

$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified.

| #  | Characteristic                                                                            | Symbol             | Min                    | Typ | Max  | Units |
|----|-------------------------------------------------------------------------------------------|--------------------|------------------------|-----|------|-------|
| 43 | Sensitivity (10-bit output @ 100 Hz, referenced to 0 Hz)<br>±60g Range                    | *                  | SENS                   | —   | 8    | —     |
| 44 | ±120g Range                                                                               | *                  | SENS                   | —   | 4    | —     |
| 45 | ±240g Range                                                                               | *                  | SENS                   | —   | 2    | —     |
| 46 | ±480g Range                                                                               | *                  | SENS                   | —   | 1    | —     |
| 47 | Total Sensitivity Error (including non-linearity)<br>$T_A = 25^\circ C$ , $\leq \pm 240g$ | *                  | ΔSENS_240              | -5  | —    | +5    |
| 48 | $T_L \leq T_A \leq T_H$ , $\leq \pm 240g$                                                 | *                  | ΔSENS_240              | -7  | —    | +7    |
| 49 | $T_L \leq T_A \leq T_H$ , $\leq \pm 240g$ , $V_{VCC\_UV\_F} \leq V_{CC} \leq V_L$         | *                  | ΔSENS_240              | -7  | —    | +7    |
| 50 | $T_A = 25^\circ C$ , $> \pm 240g$                                                         | *                  | ΔSENS_480              | -5  | —    | +5    |
| 51 | $T_L \leq T_A \leq T_H$ , $> \pm 240g$                                                    | *                  | ΔSENS_480              | -7  | —    | +7    |
| 52 | $T_L \leq T_A \leq T_H$ , $> \pm 240g$ , $V_{VCC\_UV\_F} \leq V_{CC} \leq V_L$            | *                  | ΔSENS_480              | -7  | —    | +7    |
| 53 | Digital Offset Before Offset Cancellation<br>10-bit                                       | *                  | OFF <sub>10Bit</sub>   | -52 | 0    | +52   |
| 54 | 10-bit, $T_L \leq T_A \leq T_H$ , $V_{VCC\_UV\_F} \leq V_{CC} \leq V_L$                   | *                  | OFF <sub>10Bit</sub>   | -52 | 0    | +52   |
| 55 | Digital Offset After Offset Cancellation<br>10-bit, 0.3 Hz HPF or 0.1 Hz HPF              | *                  | OFF <sub>10Bit</sub>   | -1  | 0    | +1    |
| 56 | 10-bit, 0.04 Hz HPF                                                                       | *                  | OFF <sub>10Bit</sub>   | -2  | 0    | +2    |
| 57 | Continuous Offset Monitor Limit<br>10-bit output, before compensation                     | OFF <sub>MON</sub> | -66                    | —   | +66  | LSB   |
| 58 | Range of Output (10-bit Mode)<br>Acceleration                                             | RANGE              | -480                   | —   | +480 | LSB   |
| 59 | Cross-Axis Sensitivity<br>Z-axis to X-axis                                                | *                  | V <sub>ZX</sub>        | -5  | —    | +5    |
| 60 | Y-axis to X-axis                                                                          | *                  | V <sub>YX</sub>        | -5  | —    | +5    |
| 61 | System Output Noise Peak (10-bit Mode, 1 Hz - 1 kHz, All Ranges)                          | *                  | n <sub>Peak</sub>      | -4  | —    | +4    |
| 62 | System Output Noise RMS (10-bit mode, 1 Hz - 1 kHz, All Ranges)                           | *                  | n <sub>RMS</sub>       | —   | —    | +1.0  |
| 63 | Non-linearity<br>10-bit output, $\leq \pm 240g$                                           |                    | NL <sub>OUT_240g</sub> | -2  | —    | +2    |
| 64 | 10-bit output, $> \pm 240g$                                                               |                    | NL <sub>OUT_480g</sub> | -2  | —    | +2    |

MMA52xxAKW

## 2.5 Electrical Characteristics - Self-Test and Overload

$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified.

| #  | Characteristic                                                                             | Symbol                       | Min  | Typ  | Max  | Units |
|----|--------------------------------------------------------------------------------------------|------------------------------|------|------|------|-------|
| 65 | 10-Bit Output During Active Self-Test ( $T_L \leq T_A \leq T_H$ )<br>$\pm 60g$ Range       | *<br>g <sub>ST10_60X</sub>   | 120  | —    | 280  | LSB   |
| 66 | $\pm 120g$ Range                                                                           | *<br>g <sub>ST10_120X</sub>  | 40   | —    | 160  | LSB   |
| 67 | $\pm 240g$ Range                                                                           | *<br>g <sub>ST10_240X</sub>  | 56   | —    | 184  | LSB   |
| 68 | $\pm 480g$ Range                                                                           | *<br>g <sub>ST10_480X</sub>  | 8    | —    | 112  | LSB   |
| 69 | Acceleration (without hitting internal g-cell stops)<br>$\pm 60g$ Range Positive/Negative  | g <sub>g-cell_Clip60X</sub>  | 400  | 456  | 500  | g     |
| 70 | Acceleration (without hitting internal g-cell stops)<br>$\pm 120g$ Range Positive/Negative | g <sub>g-cell_Clip120X</sub> | 400  | 456  | 500  | g     |
| 71 | Acceleration (without hitting internal g-cell stops)<br>$\pm 240g$ Range Positive/Negative | g <sub>g-cell_Clip240X</sub> | 1750 | 2065 | 2300 | g     |
| 72 | Acceleration (without hitting internal g-cell stops)<br>$\pm 480g$ Range Positive/Negative | g <sub>g-cell_Clip480X</sub> | 1750 | 2065 | 2300 | g     |
| 73 | $\Sigma\Delta$ and Sinc Filter Clipping Limit<br>$\pm 60g$ Range Positive/Negative         | g <sub>ADC_Clip60X</sub>     | 191  | 210  | 233  | g     |
| 74 | $\Sigma\Delta$ and Sinc Filter Clipping Limit<br>$\pm 120g$ Range Positive/Negative        | g <sub>ADC_Clip120X</sub>    | 353  | 380  | 410  | g     |
| 75 | $\Sigma\Delta$ and Sinc Filter Clipping Limit<br>$\pm 240g$ Range Positive/Negative        | g <sub>ADC_Clip240X</sub>    | 928  | 1055 | 1218 | g     |
| 76 | $\Sigma\Delta$ and Sinc Filter Clipping Limit<br>$\pm 480g$ Range Positive/Negative        | g <sub>ADC_Clip480X</sub>    | 1690 | 1879 | 2106 | g     |

## 2.6 Dynamic Electrical Characteristics - PSI5

$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified

| #  | Characteristic                                           | Symbol                  | Min    | Typ                | Max    | Units   |
|----|----------------------------------------------------------|-------------------------|--------|--------------------|--------|---------|
| 77 | Initialization Timing                                    |                         |        |                    |        |         |
| 78 | Phase 1                                                  | $t_{PSI5\_INIT1}$       | —      | $532000 / f_{OSC}$ | —      | s       |
| 79 | Phase 2 (10-Bit, Asynchronous Mode 0, k = 8)             | $t_{PSI5\_INIT2\_10a0}$ | —      | $512 * t_{ASYNC}$  | —      | s       |
| 80 | Phase 3 (10-Bit, Asynchronous Mode 0, ST_RPT = 0)        | $t_{PSI5\_INIT3\_10a0}$ | —      | $19 * t_{ASYNC}$   | —      | s       |
| 81 | Offset Cancellation Stage 1 Operating Time               | $t_{OC1}$               | —      | $320000 / f_{OSC}$ | —      | s       |
| 82 | Offset Cancellation Stage 2 Operating Time               | $t_{OC2}$               | —      | $280000 / f_{OSC}$ | —      | s       |
| 83 | Self-Test Stage 1 Operating Time                         | $t_{ST1}$               | —      | $128000 / f_{OSC}$ | —      | s       |
| 84 | Self-Test Stage 2 Operating Time                         | $t_{ST2}$               | —      | $128000 / f_{OSC}$ | —      | s       |
| 85 | Self-Test Stage 3 Operating Time                         | $t_{ST3}$               | —      | $128000 / f_{OSC}$ | —      | s       |
| 86 | Self-Test Repetitions                                    | $ST\_RPT$               | 0      | —                  | 5      | (7, 12) |
|    | Programming Mode Entry Window                            | $t_{PME}$               | —      | $300000 / f_{OSC}$ | —      | s       |
| 87 | Data Transmission Single Bit Time (PSI5 Low Bit Rate)    | $t_{BIT\_LOW}$          | 7.6000 | 8.0000             | 8.4000 | $\mu s$ |
| 88 | Modulation Current (20% to 80% of $I_{MOD} - I_{IDLE}$ ) | $t_{RISE}$              | 324    | 463                | 602    | ns      |
| 89 | Rise Time                                                |                         |        |                    |        | (3)     |
| 90 | Position of bit transition (PSI5 Low Baud Rate)          | $t_{Bittrans\_LowBaud}$ | 49     | 50                 | 51     | %       |
|    | Asynchronous Response Time                               | $t_{ASYNC}$             | —      | $912 / f_{OSC}$    | —      | s       |
|    |                                                          |                         |        |                    |        | (7)     |

## 2.7 Dynamic Electrical Characteristics - Signal Chain

$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified

| #   | Characteristic                                        | Symbol                   | Min   | Typ              | Max   | Units   |
|-----|-------------------------------------------------------|--------------------------|-------|------------------|-------|---------|
| 91  | Internal Oscillator Frequency                         | $f_{OSC}$                | 3.80  | 4                | 4.20  | MHz     |
| 92  | DSP Low-Pass Filter (Note15)                          | $f_{C\_LPF0}$            | —     | 400              | —     | (1)     |
| 93  | Cutoff frequency LPF0 (referenced to 0 Hz)            | $O_{LPF0}$               | —     | 3                | —     | Hz      |
|     | Filter Order LPF0                                     |                          |       |                  |       | (7)     |
| 94  | DSP Offset Cancellation Low-Pass Filter (Note 15)     | $t_{OC\_SampleRate}$     | —     | 256              | —     | $\mu s$ |
| 95  | Offset Cancellation Low-Pass Filter Input Sample Rate | $f_{C\_OC10}$            | —     | 10.0             | —     | Hz      |
| 96  | Stage 1 Cutoff frequency, Startup Phase 1             | $O_{OC10}$               | —     | 1                | —     | (7)     |
| 97  | Stage 1 Filter Order, Startup Phase 1                 | $f_{C\_OC03}$            | —     | 0.300            | —     | Hz      |
| 98  | Stage 2 Cutoff frequency, Startup Phase 1             | $O_{OC03}$               | —     | 1                | —     | (7)     |
| 99  | Stage 2 Filter Order, Startup Phase 1                 | $f_{C\_OC0}$             | —     | 0.100            | —     | Hz      |
| 100 | Cutoff frequency, Option 0                            | $O_{OC0}$                | —     | 1                | —     | (7)     |
| 101 | Filter Order, Option 0                                | $t_{OffRate\_10}$        | —     | $f_{OSC} / 2e6$  | —     | s       |
| 102 | Offset Cancellation Output Update Rate (10-Bit Mode)  | $OFF_{Step\_10}$         | —     | 0.5              | —     | LSB     |
| 103 | Offset Cancellation Output Step Size (10-Bit Mode)    | $OFFMON_{OSC}$           | —     | $f_{OSC} / 2000$ | —     | Hz      |
| 104 | Offset Monitor Update Frequency                       | $OFFMON_{CNTLIMIT}$      | —     | 4096             | —     | (7)     |
| 105 | Offset Monitor Count Limit                            | $OFFMON_{CNTSIZE}$       | —     | 8192             | —     | 1       |
|     | Offset Monitor Counter Size                           |                          |       |                  |       | (7)     |
| 106 | Sensing Element Natural Frequency $\pm 60g$           | $f_{gcell\_X60}$         | 12651 | —                | 13871 | Hz      |
| 107 | $\pm 120g$                                            | $f_{gcell\_X120}$        | 12651 | —                | 13871 | Hz      |
| 108 | $\pm 240g$                                            | $f_{gcell\_X240}$        | 26000 | —                | 28700 | Hz      |
| 109 | $\pm 480g$                                            | $f_{gcell\_X480}$        | 26000 | —                | 28700 | Hz      |
|     |                                                       |                          |       |                  |       | (9)     |
| 110 | Sensing Element Rolloff Frequency (-3 db) $\pm 60g$   | $f_{gcell\_X60}$         | 938   | —                | 2592  | Hz      |
| 111 | $\pm 120g$                                            | $f_{gcell\_X120}$        | 938   | —                | 2592  | Hz      |
| 112 | $\pm 240g$                                            | $f_{gcell\_X240}$        | 3952  | —                | 14370 | Hz      |
| 113 | $\pm 480g$                                            | $f_{gcell\_X480}$        | 3952  | —                | 14370 | Hz      |
|     |                                                       |                          |       |                  |       | (9)     |
| 114 | Sensing Element Damping Ratio $\pm 60g$               | $\zeta_{gcell\_X60}$     | 2.760 | —                | 6.770 | —       |
| 115 | $\pm 120g$                                            | $\zeta_{gcell\_X120}$    | 2.760 | —                | 6.770 | —       |
| 116 | $\pm 240g$                                            | $\zeta_{gcell\_X240}$    | 1.260 | —                | 3.602 | —       |
| 117 | $\pm 480g$                                            | $\zeta_{gcell\_X480}$    | 1.260 | —                | 3.602 | —       |
|     |                                                       |                          |       |                  |       | (9)     |
| 118 | Sensing Element Delay (@100 Hz) $\pm 60g$             | $f_{gcell\_delay\_X60}$  | 63    | —                | 170   | $\mu s$ |
| 119 | $\pm 120g$                                            | $f_{gcell\_delay\_X120}$ | 63    | —                | 170   | $\mu s$ |
| 120 | $\pm 240g$                                            | $f_{gcell\_delay\_X240}$ | 13    | —                | 40    | $\mu s$ |
| 121 | $\pm 480g$                                            | $f_{gcell\_delay\_X480}$ | 13    | —                | 40    | $\mu s$ |
|     |                                                       |                          |       |                  |       | (9)     |
| 122 | Package Resonance Frequency                           | $f_{Package}$            | 100   | —                | —     | kHz     |
|     |                                                       |                          |       |                  |       | (9)     |

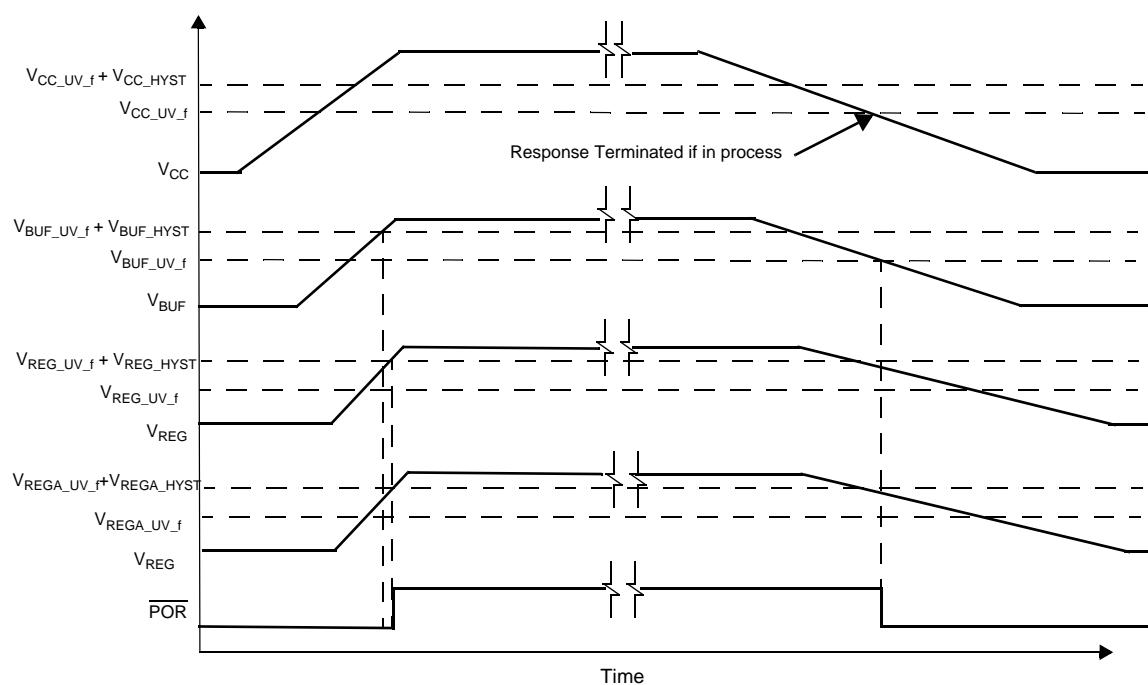
**MMA52xxAKW**

## 2.8 Dynamic Electrical Characteristics - Supply and SPI

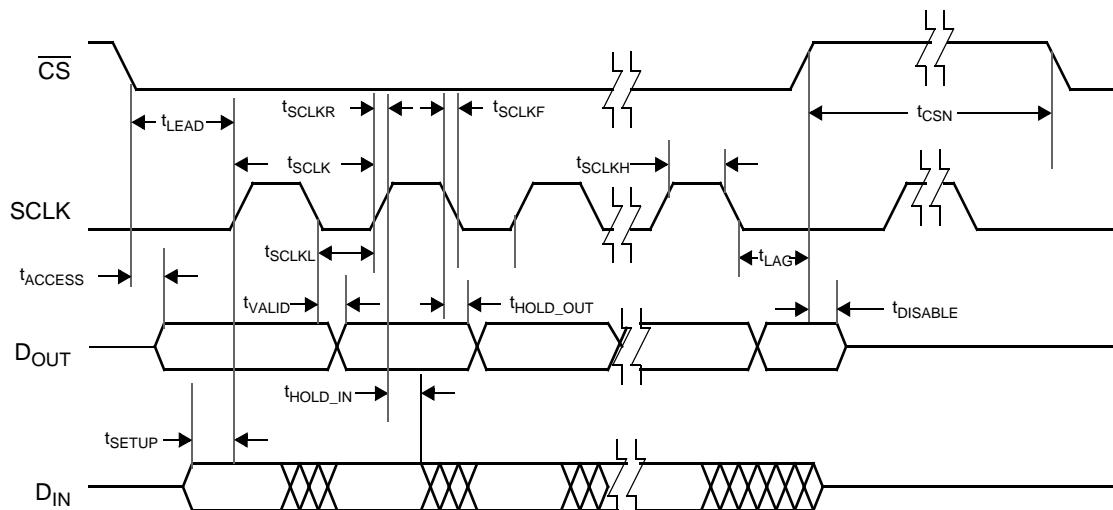
$V_L \leq (V_{CC} - V_{SS}) \leq V_H$ ,  $T_L \leq T_A \leq T_H$ ,  $\Delta T \leq 25$  K/min, unless otherwise specified

| #   | Characteristic                                                                                | Symbol                 | Min  | Typ               | Max  | Units   |     |
|-----|-----------------------------------------------------------------------------------------------|------------------------|------|-------------------|------|---------|-----|
| 123 | Quiescent Current Settling Time (Power Applied to $I_Q = I_{IDLE} \pm 2$ mA)                  | $t_{SET}$              | —    | —                 | 5    | ms      | (3) |
| 124 | Reset Recovery Internal Delay (After internal POR)                                            | $t_{INT\_INIT}$        | —    | $16000 / f_{OSC}$ | —    | s       | (7) |
| 125 | $V_{CC}$ Micro-cut ( $C_{BUF}=C_{REG}=C_{REGA}=1$ $\mu$ F)                                    | $t_{VCC\_MICROCUTmin}$ | 30   | —                 | —    | $\mu$ s | (3) |
| 126 | Survival Time ( $V_{CC}$ disconnect without Reset, $C_{BUF}=C_{REG}=C_{REGA}=700$ nF)         | $t_{VCC\_MICROCUT}$    | 50   | —                 | —    | $\mu$ s | (3) |
| 127 | Survival Time ( $V_{CC}$ disconnect without Reset, $C_{BUF}=C_{REG}=C_{REGA}=1$ $\mu$ F)      | $t_{VCC\_RESET}$       | —    | —                 | 1000 | $\mu$ s | (3) |
| 128 | $V_{BUF}$ , Capacitor Monitor Disconnect Time (Figure 9)                                      | $t_{POR\_CAPTEST}$     | —    | $12000 / f_{OSC}$ | —    | s       | (7) |
| 129 | POR to first Capacitor Test Disconnect                                                        | $t_{CAPTEST\_ADLY}$    | —    | $688 / f_{OSC}$   | —    | s       | (7) |
| 130 | $V_{REG}, V_{REGA}$ Capacitor Monitor                                                         | $t_{POR\_CAPTEST}$     | —    | $12000 / f_{OSC}$ | —    | s       | (7) |
| 131 | POR to first Capacitor Test Disconnect                                                        | $t_{CAPTEST\_RATE}$    | —    | $256 / f_{OSC}$   | —    | s       | (7) |
| 132 | Serial Interface Timing (See Figure 6, $C_{DOUT} \leq 80$ pF, $R_{DOUT} \geq 10$ k $\Omega$ ) | $t_{SCLK}$             | 320  | —                 | —    | ns      | (9) |
| 133 | Clock (SCLK) period (10% of $V_{CC}$ to 10% of $V_{CC}$ )                                     | $t_{SCLKH}$            | 120  | —                 | —    | ns      | (9) |
| 134 | Clock (SCLK) high time (90% of $V_{CC}$ to 90% of $V_{CC}$ )                                  | $t_{SCLKL}$            | 120  | —                 | —    | ns      | (9) |
| 135 | Clock (SCLK) low time (10% of $V_{CC}$ to 10% of $V_{CC}$ )                                   | $t_{SCLKR}$            | —    | 15                | 40   | ns      | (9) |
| 136 | Clock (SCLK) rise time (10% of $V_{CC}$ to 90% of $V_{CC}$ )                                  | $t_{SCLKF}$            | —    | 15                | 28   | ns      | (9) |
| 137 | Clock (SCLK) fall time (90% of $V_{CC}$ to 10% of $V_{CC}$ )                                  | $t_{LEAD}$             | 60   | —                 | —    | ns      | (9) |
| 138 | CS asserted to SCLK high ( $CS = 10\%$ of $V_{CC}$ to SCLK = 10% of $V_{CC}$ )                | $t_{ACCESS}$           | —    | —                 | 60   | ns      | (9) |
| 139 | CS asserted to $D_{OUT}$ valid ( $CS = 10\%$ of $V_{CC}$ to $D_{OUT} = 10/90\%$ of $V_{CC}$ ) | $t_{SETUP}$            | 20   | —                 | —    | ns      | (9) |
| 140 | Data setup time ( $D_{IN} = 10/90\%$ of $V_{CC}$ to SCLK = 10% of $V_{CC}$ )                  | $t_{HOLD\_IN}$         | 10   | —                 | —    | ns      | (9) |
| 141 | $D_{IN}$ Data hold time (SCLK = 90% of $V_{CC}$ to $D_{IN} = 10/90\%$ of $V_{CC}$ )           | $t_{HOLD\_OUT}$        | 0    | —                 | —    | ns      | (9) |
| 142 | $D_{OUT}$ Data hold time (SCLK = 90% of $V_{CC}$ to $D_{OUT} = 10/90\%$ of $V_{CC}$ )         | $t_{VALID}$            | —    | —                 | 50   | ns      | (9) |
| 143 | SCLK low to data valid (SCLK = 10% of $V_{CC}$ to $D_{OUT} = 10/90\%$ of $V_{CC}$ )           | $t_{LAG}$              | 60   | —                 | —    | ns      | (9) |
| 144 | SCLK low to CS high (SCLK = 10% of $V_{CC}$ to CS = 90% of $V_{CC}$ )                         | $t_{DISABLE}$          | —    | —                 | 60   | ns      | (9) |
| 145 | CS high to $D_{OUT}$ disable (CS = 90% of $V_{CC}$ to $D_{OUT} = Hi Z$ )                      | $t_{CSN}$              | 1000 | —                 | —    | ns      | (9) |
|     | CS high to CS low (CS = 90% of $V_{CC}$ to CS = 90% of $V_{CC}$ )                             |                        |      |                   |      |         |     |

1. Parameters tested 100% at final test.
2. Parameters tested 100% at wafer probe.
3. Verified by characterization
4. \* Indicates critical characteristic.
5. Verified by qualification testing.
6. Parameters verified by pass/fail testing in production.
7. Functionality guaranteed by modeling, simulation and/or design verification. Circuit integrity assured through IDDQ and scan testing. Timing is determined by internal system clock frequency.
8. N/A.
9. Verified by simulation.
10. N/A.
11. Measured at  $V_{CC}$  pin;  $V_{SYNC}$  guaranteed across full  $V_{IDLE}$  range.
12. Self-Test repeats on failure up to a  $ST\_RPT_{MAX}$  times before transmitting Sensor Error Message.
13. N/A.
14. Thermal resistance between the die junction and the exposed pad; cold plate is attached to the exposed pad.
15. Filter cutoff frequencies are directly dependent upon the internal oscillator frequency.



**Figure 5. Powerup Timing**



**Figure 6. Serial Interface Timing**

### 3 Functional Description

#### 3.1 User Accessible Data Array

A user accessible data array allows for each device to be customized. The array consists of an OTP factory programmable block, an OTP user programmable block, and read-only registers for device status. The OTP blocks incorporate independent error detection circuitry for fault detection (reference [Section 3.2](#)). Portions of the factory programmable array are reserved for factory-programmed trim values. The user accessible data is shown in [Table 2](#).

**Table 2. User Accessible Data**

| Byte Addr (XLong Msg) | Register | Nibble Addr (Long Msg) | Bit Function |        |          |        | Nibble Addr (Long Msg) | Bit Function |        |        |        | Type |
|-----------------------|----------|------------------------|--------------|--------|----------|--------|------------------------|--------------|--------|--------|--------|------|
|                       |          |                        | 7            | 6      | 5        | 4      |                        | 3            | 2      | 1      | 0      |      |
| \$00                  | SN0      | \$01                   | SN[7]        | SN[6]  | SN[5]    | SN[4]  | \$00                   | SN[3]        | SN[2]  | SN[1]  | SN[0]  | R    |
| \$01                  | SN1      | \$03                   | SN[15]       | SN[14] | SN[13]   | SN[12] | \$02                   | SN[11]       | SN[10] | SN[9]  | SN[8]  |      |
| \$02                  | SN2      | \$05                   | SN[23]       | SN[22] | SN[21]   | SN[20] | \$04                   | SN[19]       | SN[18] | SN[17] | SN[16] |      |
| \$03                  | SN3      | \$07                   | SN[31]       | SN[30] | SN[29]   | SN[28] | \$06                   | SN[27]       | SN[26] | SN[25] | SN[24] |      |
| \$04                  | DEVCFG1  | \$09                   | 0            | 0      | 1        | 0      | \$08                   | 0            | RNG[2] | RNG[1] | RNG[0] |      |
| \$05                  | DEVCFG2  | \$0B                   | 0            | 0      | 0        | 0      | \$0A                   | 0            | 0      | 0      | 0      |      |
| \$06                  | DEVCFG3  | \$0D                   | 0            | 0      | 0        | 0      | \$0C                   | 0            | 0      | 0      | 0      |      |
| \$07                  | DEVCFG4  | \$0F                   | 0            | 0      | 0        | 0      | \$0E                   | 0            | 0      | 0      | 0      |      |
| \$08                  | DEVCFG5  | \$11                   | 0            | 0      | 0        | 0      | \$10                   | 0            | 0      | 0      | 0      |      |
| \$09                  | DEVCFG6  | \$13                   | 0            | 1      | 0        | 0      | \$12                   | 0            | 0      | 0      | 0      |      |
| \$0A                  | DEVCFG7  | \$15                   | 0            | 0      | 0        | 0      | \$14                   | 0            | 0      | 0      | 0      |      |
| \$0B                  | DEVCFG8  | \$17                   | 1            | 0      | 1        | 0      | \$16                   | 0            | 0      | 0      | 0      |      |
| \$0C                  | SC       | \$19                   | 0            | TM_B   | RESERVED | IDEN_B | \$18                   | OC_INIT_B    | IDEF_B | OFF_B  | 0      |      |
| \$0D                  | MFG_ID   | \$1B                   | 0            | 0      | 0        | 0      | \$1A                   | 0            | 0      | 0      | 0      |      |

Type codes

R: Readable register via PSI5

#### 3.1.1 Device Serial Number Registers

A unique serial number is programmed into the serial number registers of each device during manufacturing. The serial number is composed of the following information:

| Bit Range | Content       |
|-----------|---------------|
| SN[12:0]  | Serial Number |
| SN[31:13] | Lot Number    |

Serial numbers begin at 1 for all produced devices in each lot and are sequentially assigned. Lot numbers begin at 1 and are sequentially assigned. No lot will contain more devices than can be uniquely identified by the 13-bit serial number. Depending on lot size and quantities, all possible lot numbers and serial numbers may not be assigned.

The serial number registers are included in the factory programmed OTP CRC verification. Reference [Section 3.2](#) for details regarding the CRC verification. Beyond this, the contents of the serial number registers have no impact on device operation or performance, and are only used for traceability purposes.

### 3.1.2 Factory Configuration Register (DEVCFG1)

The factory configuration register is a factory programmed, read-only register which contains user specific device configuration information. The factory configuration register is included in the factory programmed OTP CRC verification.

| Location        |          | Bit |   |   |   |   |        |        |        |
|-----------------|----------|-----|---|---|---|---|--------|--------|--------|
| Address         | Register | 7   | 6 | 5 | 4 | 3 | 2      | 1      | 0      |
| \$04            | DEVCFG1  | 0   | 0 | 1 | 0 | 0 | RNG[2] | RNG[1] | RNG[0] |
| Factory Default |          | 0   | 0 | 1 | 0 | 0 | 0      | 0      | 0      |

#### 3.1.2.1 Range Indication Bits (RNG[2:0])

The range indication bits are factory programmed and indicate the full-scale range of the device as shown below.

| RNG[2] | RNG[1] | RNG[0] | Full-Scale Acceleration Range | g-Cell Design | PSI5 Init Data Transmission (D9)<br>Reference Table 9 |
|--------|--------|--------|-------------------------------|---------------|-------------------------------------------------------|
| 0      | 0      | 0      | Reserved                      | N/A           | 0001                                                  |
| 0      | 0      | 1      | ±60g                          | Medium-g      | 0111                                                  |
| 0      | 1      | 0      | Reserved                      | N/A           | 0010                                                  |
| 0      | 1      | 1      | ±120 g                        | Medium-g      | 1000                                                  |
| 1      | 0      | 0      | Reserved                      | N/A           | 0011                                                  |
| 1      | 0      | 1      | ±240 g                        | High-g        | 1001                                                  |
| 1      | 1      | 0      | Reserved                      | N/A           | 0100                                                  |
| 1      | 1      | 1      | ±480 g                        | High-g        | 1010                                                  |

### 3.1.3 Status Check Register (SC)

The status check register is a read-only register containing device status information.

| Location |          | Bit |      |          |        |           |        |       |   |
|----------|----------|-----|------|----------|--------|-----------|--------|-------|---|
| Address  | Register | 7   | 6    | 5        | 4      | 3         | 2      | 1     | 0 |
| \$0C     | SC       | 0   | TM_B | RESERVED | IDEN_B | OC_INIT_B | IDEF_B | OFF_B | 0 |

#### 3.1.3.1 Test Mode Flag (TM\_B)

The test mode bit is cleared if the device is in test mode.

| TM_B | Operating Mode          |
|------|-------------------------|
| 0    | Test Mode is active     |
| 1    | Test Mode is not active |

#### 3.1.3.2 Internal Data Error Flag (IDEN\_B)

The internal data error bit is cleared if a register data error detection mismatch is detected in the user accessible OTP array. A device reset is required to clear the error.

| IDEN_B | Error Condition                                         |
|--------|---------------------------------------------------------|
| 0      | Error detection mismatch in user programmable OTP array |
| 1      | No error detected                                       |

### 3.1.3.3 Offset Cancellation Init Status Flag (OC\_INIT\_B)

The offset cancellation initialization status bit is set once the offset cancellation initialization process is complete, and the filter has switched to normal mode.

| OC_INIT_B | Error Condition                                                                |
|-----------|--------------------------------------------------------------------------------|
| 0         | Offset Cancellation in initialization                                          |
| 1         | Offset Cancellation initialization complete ( $t_{OC1}$ and $t_{OC2}$ expired) |

### 3.1.3.4 Internal Factory Data Error Flag (IDEF\_B)

The internal factory data error bit is cleared if a register data CRC fault is detected in the factory programmable OTP array. A device reset is required to clear the error.

| IDEF_B | Error Condition                             |
|--------|---------------------------------------------|
| 0      | CRC error in factory programmable OTP array |
| 1      | No error detected                           |

### 3.1.3.5 Offset Error Flag (OFF\_B)

The offset error flag is cleared if the acceleration signal reaches the offset limit.

| OFF_B | Error Condition       |
|-------|-----------------------|
| 0     | Offset error detected |
| 1     | No error detected     |

## 3.2 OTP Array Error Detection

The Factory programmed OTP array is verified for errors with a 3-bit CRC. The CRC verification is enabled only when the factory programmed array is locked. The CRC verification uses a generator polynomial of  $g(x) = X^3 + X + 1$ , with a seed value = '111'.

The CRC is continuously calculated on the factory programmable array with the exception of the factory lock bits. Bits are fed in from right to left (LSB first), and top to bottom (lower addresses first) in the register map. The calculated CRC is then compared against the stored 3 bit CRC. If a CRC error is detected in the OTP array, the IDEF\_B bit is cleared in the SC register.

The CRC verification is completed on the memory registers which hold a copy of the fuse array values, not the fuse array values.

### 3.3 Voltage Regulators

The device derives its internal supply voltage from the  $V_{CC}$  and  $V_{SS}$  pins. Separate internal voltage regulators are used for the analog ( $V_{REGA}$ ) and digital circuitry ( $V_{REG}$ ). The analog and digital regulators are supplied by a buffer regulator ( $V_{BUF}$ ) to provide immunity from EMC and supply dropouts on  $V_{CC}$ . External filter capacitors are required, as shown in Figure 1.

The voltage regulator module includes voltage monitoring circuitry which holds the device in reset following power-on until the internal voltages have increased above the undervoltage detection thresholds. The voltage monitor asserts internal reset when the external supply or internally regulated voltages fall below the undervoltage detection thresholds. A reference generator provides a reference voltage for the  $\Sigma\Delta$  converter.

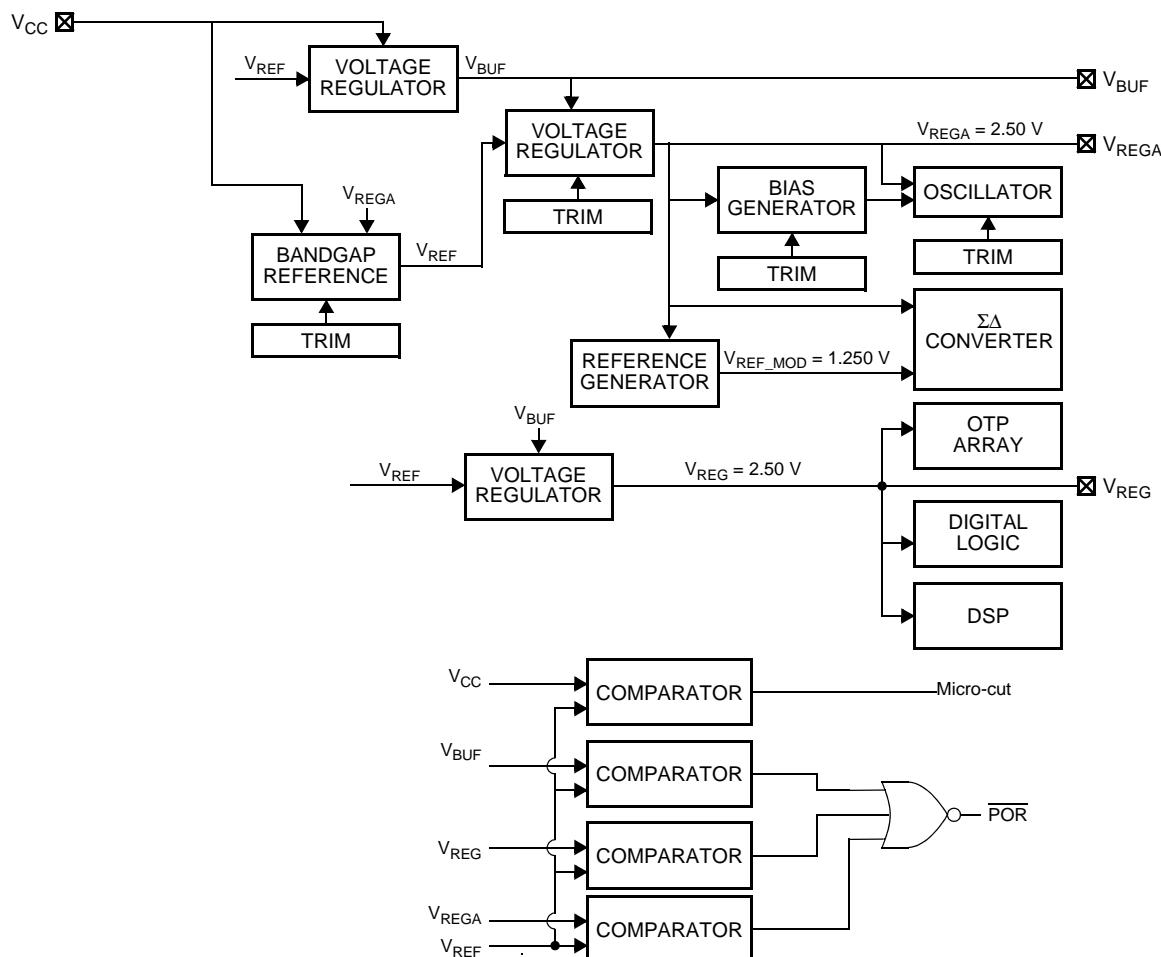


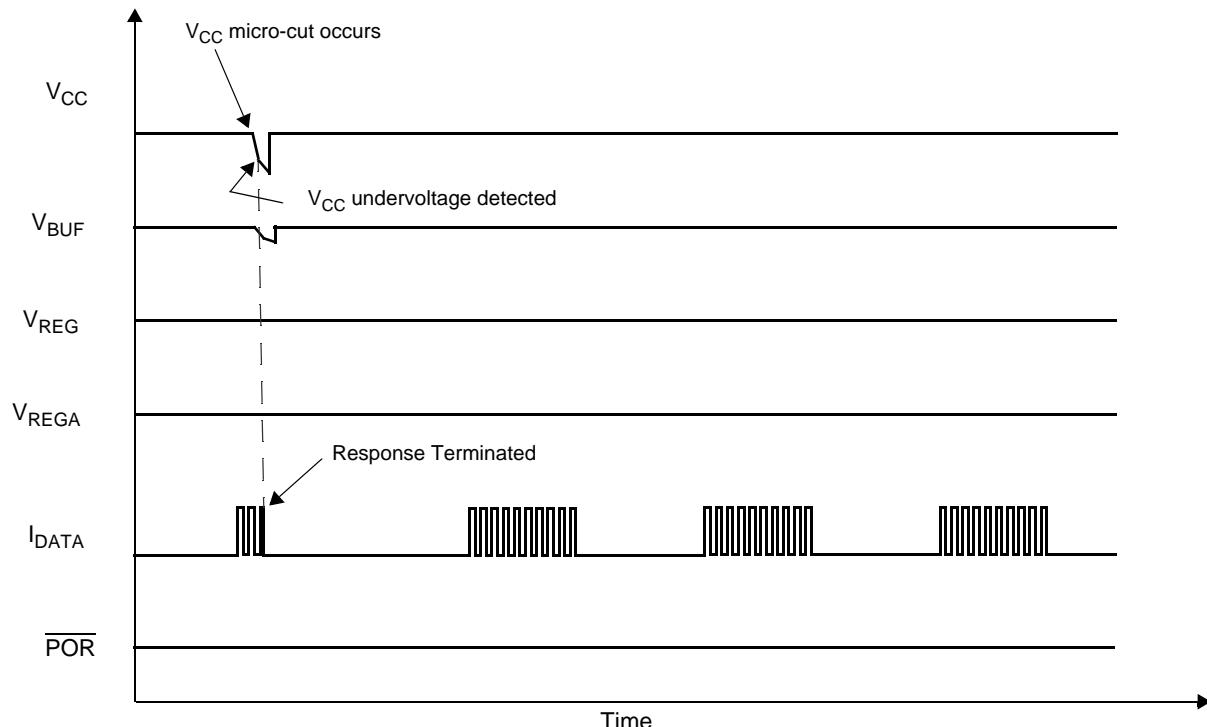
Figure 7. Voltage Regulation and Monitoring

### 3.3.1 $V_{BUF}$ , $V_{REG}$ , and $V_{REGA}$ Regulator Capacitor

The internal regulators require an external capacitor between each of the regulator pins ( $V_{BUF}$ ,  $V_{REG}$ , or  $V_{REGA}$ ) and the associated the  $V_{SS}$  /  $V_{SSA}$  pin for stability. [Figure 1](#) shows the recommended types and values for each of these capacitors.

### 3.3.2 $V_{CC}$ , $V_{BUF}$ , $V_{REG}$ , and $V_{REGA}$ Undervoltage Monitor

A circuit is incorporated to monitor the supply voltage ( $V_{CC}$ ) and all internally regulated voltages ( $V_{BUF}$ ,  $V_{REG}$ , and  $V_{REGA}$ ). If any of internal regulator voltages fall below the specified undervoltage thresholds in [Section 2](#), the device will be reset. If  $V_{CC}$  falls below the specified threshold, PSI5 transmissions are terminated for the present response. Once the supply returns above the threshold, the device will respond to the next detected sync pulse. Reference [Figure 8](#).



**Figure 8.  $V_{CC}$  Micro-Cut Response**

### 3.3.3 $V_{BUF}$ , $V_{REG}$ , and $V_{REGA}$ Capacitance Monitor

A monitor circuit is incorporated to ensure predictable operation if the connection to the external  $V_{BUF}$ ,  $V_{REG}$  or  $V_{REGA}$ , capacitor becomes open.

The  $V_{BUF}$  regulator is disabled  $t_{CAPTEST\_ADLY}$  seconds after each data transmission for a duration of  $t_{CAPTEST\_TIME}$  seconds. If the external capacitor is not present, the regulator voltage will fall below the internal reset threshold, forcing a device reset.

The  $V_{REG}$  and  $V_{REGA}$  regulators are disabled at a continuous rate ( $t_{CAPTEST\_RATE}$ ), for a duration of  $t_{CAPTEST\_TIME}$  seconds. If either external capacitor is not present, the associated regulator voltage will fall below the internal reset threshold, forcing a device reset.

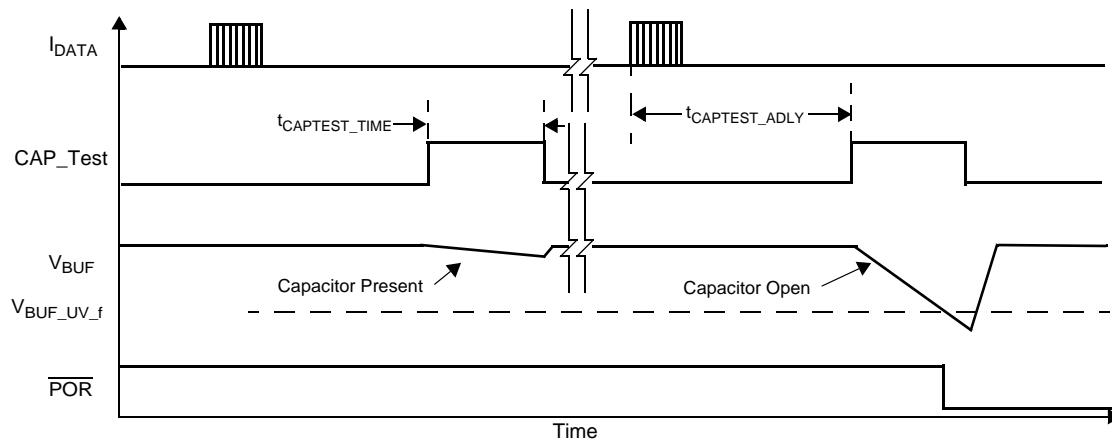


Figure 9.  $V_{BUF}$  Capacitor Monitor - Asynchronous Mode

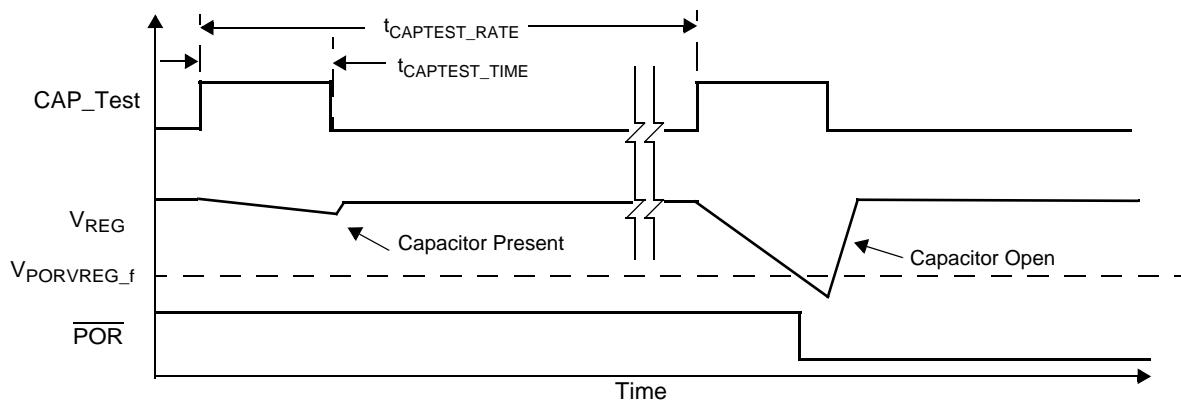


Figure 10.  $V_{REG}$  Capacitor Monitor

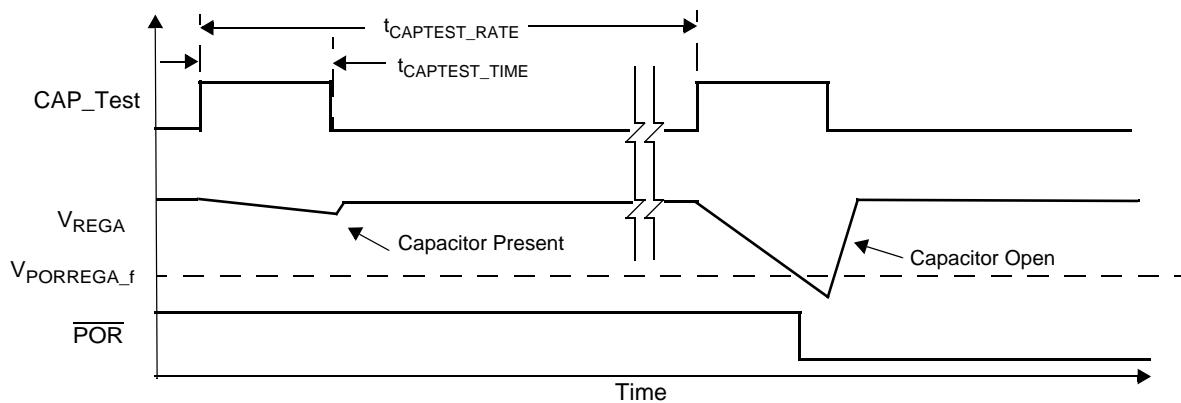


Figure 11.  $V_{REGA}$  Capacitor Monitor

### 3.4 Internal Oscillator

A factory trimmed oscillator is included as specified in [Section 2](#).

### 3.5 Acceleration Signal Path

#### 3.5.1 Transducer

The transducer is an overdamped mass-spring-damper system defined by the following transfer function:

where:

$$H(s) = \frac{\omega_n^2}{s^2 + 2 \cdot \xi \cdot \omega_n \cdot s + \omega_n^2}$$

$\zeta$  = Damping Ratio

$\omega_n$  = Natural Frequency =  $2 \cdot \pi \cdot f_n$

Reference [Section 2.7](#) for transducer parameters.

#### 3.5.2 $\Sigma\Delta$ Converter

A sigma delta modulator converts the differential capacitance of the transducer to a 1 MHz data stream that is input to the DSP block.

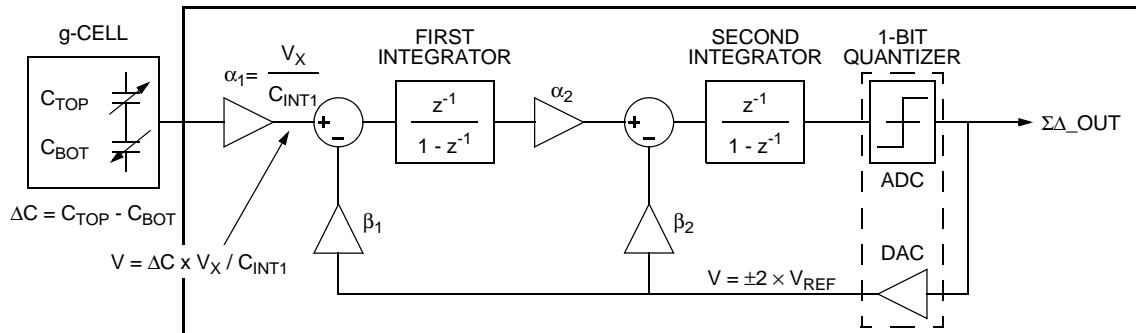
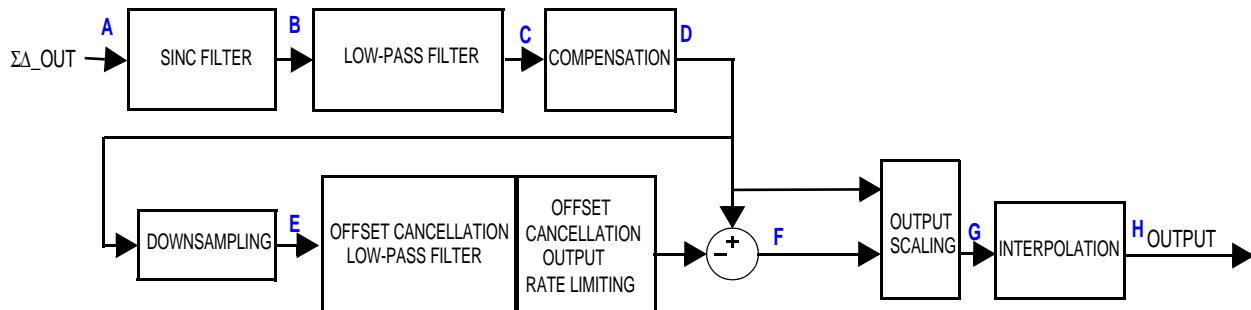


Figure 12.  $\Sigma\Delta$  Converter Block Diagram

### 3.5.3 Digital Signal Processing Block

A Digital Signal Processing (DSP) block is used to perform signal filtering and compensation. A diagram illustrating the signal processing flow within the DSP block is shown in [Figure 13](#).



**Figure 13. Signal Chain Diagram**

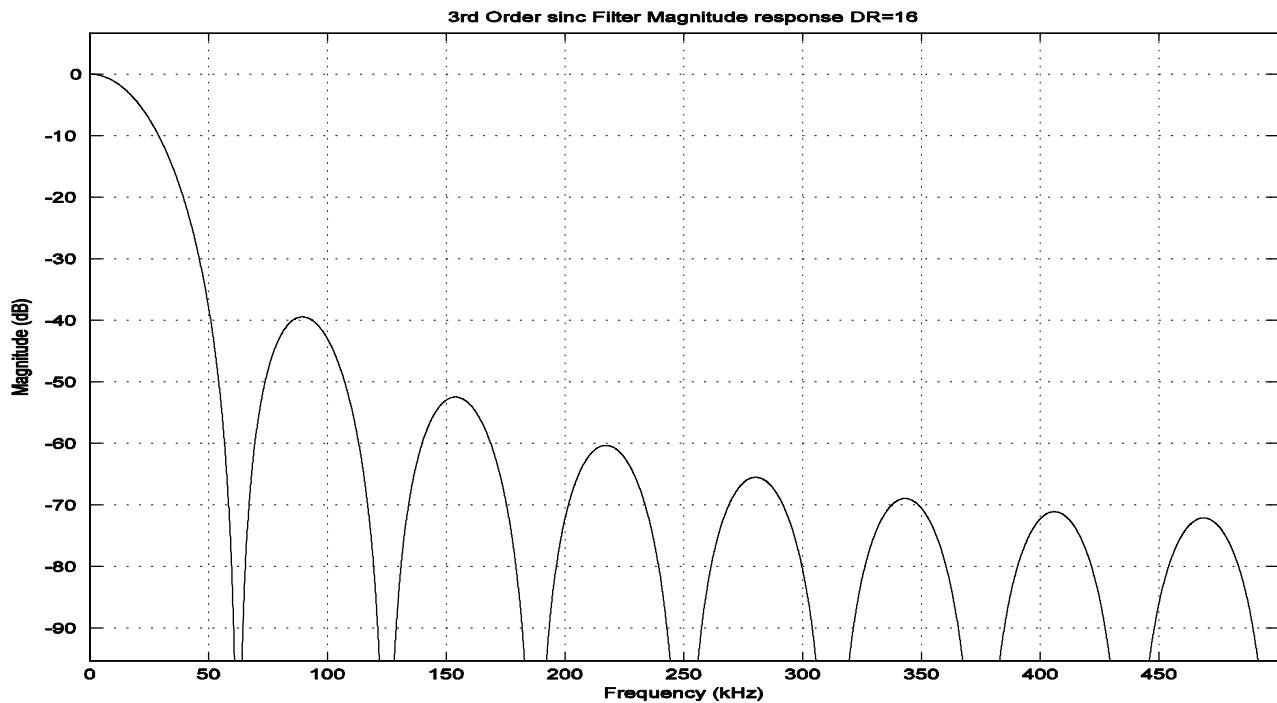
**Table 3. Signal Chain Characteristics**

|          | Description                           | Sample Time (μs) | Data Width (Bits) | Over Range (Bits) | Signal Width (Bits) | Signal Noise (Bits) | Signal Margin (Bits) | Typical Block Latency           | Reference                       |
|----------|---------------------------------------|------------------|-------------------|-------------------|---------------------|---------------------|----------------------|---------------------------------|---------------------------------|
| <b>A</b> | SD                                    | 1                | 1                 |                   | 1                   |                     |                      | 203/f <sub>osc</sub>            | <a href="#">Section 3.5.2</a>   |
| <b>B</b> | SINC Filter                           | 16               | 20                |                   | 13                  |                     |                      |                                 | <a href="#">Section 3.5.3.2</a> |
| <b>C</b> | Low-Pass Filter                       | 16               | 26                | 4                 | 10                  | 3                   | 9                    | 68/f <sub>osc</sub>             | <a href="#">Section 3.5.3.2</a> |
| <b>D</b> | Compensation                          | 16               | 26                | 4                 | 10                  | 3                   | 9                    |                                 |                                 |
| <b>E</b> | Down Sampling                         | 16               | 26                | 4                 | 10                  | 3                   | 9                    |                                 |                                 |
| <b>F</b> | High-Pass Filter                      | 16               | 26                | 4                 | 10                  | 3                   | 9                    | 4/f <sub>osc</sub>              | <a href="#">Section 3.5.3.3</a> |
| <b>G</b> | DSP Sampling<br>10-Bit Output Scaling | 16               |                   |                   | 10                  |                     |                      |                                 | <a href="#">Section 3.5.3.5</a> |
| <b>H</b> | Interpolation                         |                  |                   |                   |                     |                     | 64/f <sub>osc</sub>  | <a href="#">Section 3.5.3.5</a> |                                 |

#### 3.5.3.1 Decimation Sinc Filter

The serial data stream produced by the  $\Sigma\Delta$  converter is decimated and converted to parallel values by a 3rd order 16:1 sinc filter with a decimation factor of 16.

$$H(z) = \left[ \frac{1 - z^{-16}}{16 \times (1 - z^{-1})} \right]^3$$



**Figure 14. Sinc Filter Response,  $t_S = 16 \mu\text{s}$**

### 3.5.3.2 Low-Pass Filter

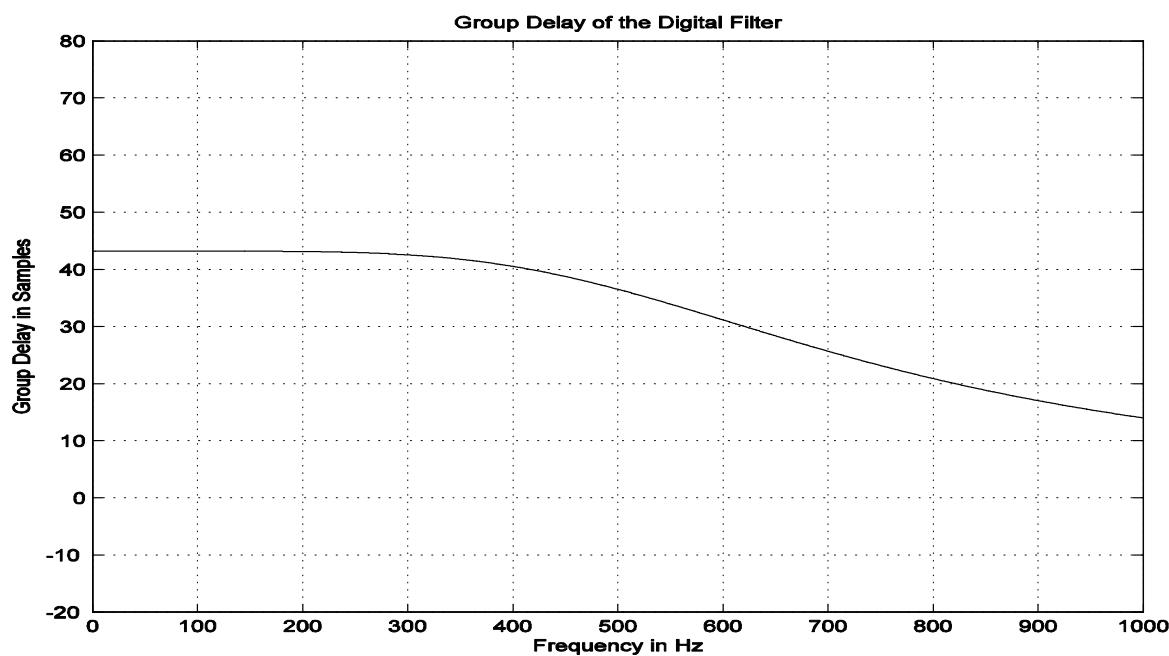
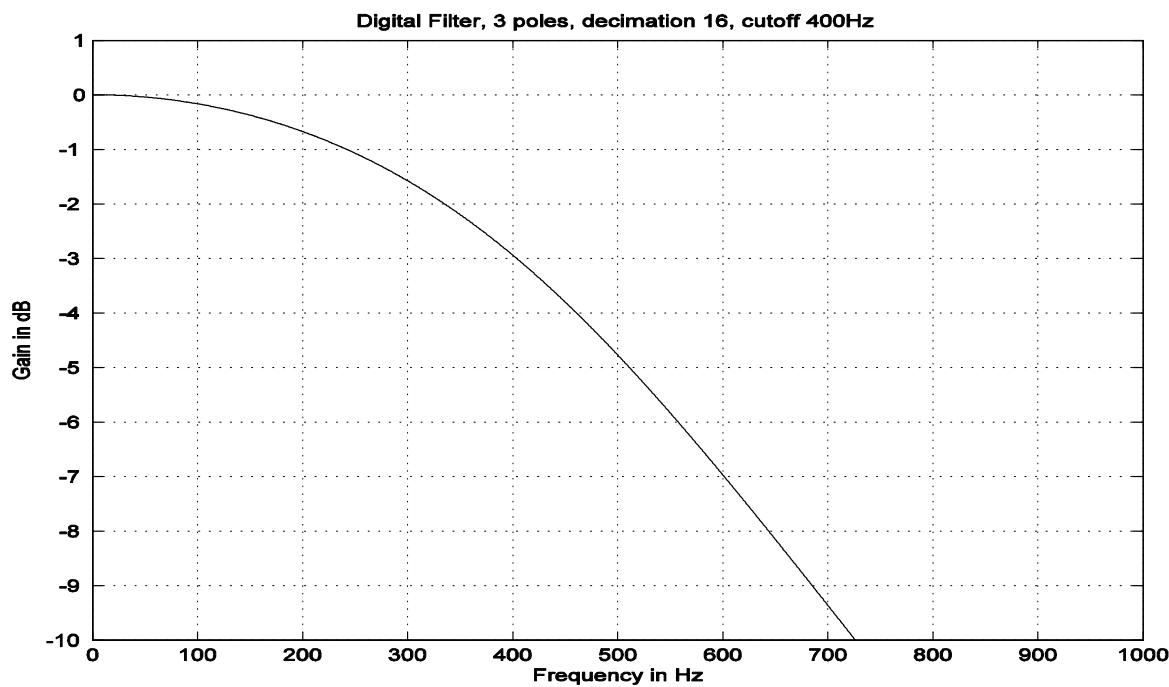
Data from the Sinc filter is processed by an infinite impulse response (IIR) low-pass filter.

$$H(z) = a_0 \cdot \frac{(n_{11} \cdot z^0) + (n_{12} \cdot z^{-1}) + (n_{13} \cdot z^{-2})}{(d_{11} \cdot z^0) + (d_{12} \cdot z^{-1}) + (d_{13} \cdot z^{-2})} \cdot \frac{(n_{21} \cdot z^0) + (n_{22} \cdot z^{-1}) + (n_{23} \cdot z^{-2})}{(d_{21} \cdot z^0) + (d_{22} \cdot z^{-1}) + (d_{23} \cdot z^{-2})}$$

**Table 4. Low-Pass Filter Coefficients**

| Description        | Filter Coefficients |                       |          |                        | Group Delay           |
|--------------------|---------------------|-----------------------|----------|------------------------|-----------------------|
| 400 Hz, 3-Pole LPF | $a_0$               | 5.189235225042199e-02 |          |                        | 2816/f <sub>osc</sub> |
|                    | $n_{11}$            | 1.629077582099646e-03 | $d_{11}$ | 1.0                    |                       |
|                    | $n_{12}$            | 1.630351547919014e-03 | $d_{12}$ | -9.481076477495780e-01 |                       |
|                    | $n_{13}$            | 0                     | $d_{13}$ | 0                      |                       |
|                    | $n_{21}$            | 2.500977520825902e-01 | $d_{21}$ | 1.0                    |                       |
|                    | $n_{22}$            | 4.999999235890745e-01 | $d_{22}$ | -1.915847097557409e+00 |                       |
|                    | $n_{23}$            | 2.499023243303036e-01 | $d_{23}$ | 9.191065266874253e-01  |                       |

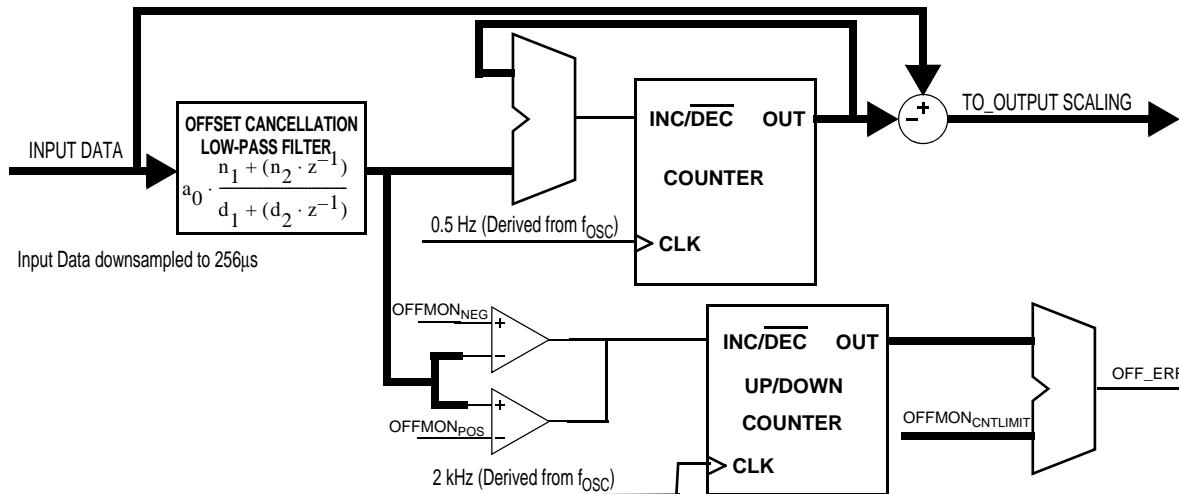
**Note:** Low-Pass Filter values do not include g-cell frequency response.



**Figure 15. Low-Pass Filter Characteristics:  $f_C = 400$  Hz, 3-Pole,  $t_S = 16 \mu\text{s}$**

### 3.5.3.3 Offset Cancellation

The device provides an offset cancellation circuit to remove internal offset error. A block diagram of the offset cancellation is shown in Figure 16.



**Figure 16. Offset Cancellation Block Diagram**

The transfer function for the offset LPF is:

$$H(z) = a_0 \cdot \frac{n_0 + (n_2 \cdot z^{-1})}{d_0 + (d_2 \cdot z^{-1})}$$

Response parameters are specified in [Section 2](#) and the offset LPF coefficients are specified in [Table 6](#).

During startup, two phases of the offset LPF are used to allow for fast convergence of the internal offset error during initialization. The timing and characteristics of each phase are shown in [Table 5](#) and [Table 6](#) and specified in [Section 2](#). For more information regarding the startup timing, reference the PSI5 initialization information in [Section 4.4](#). The offset low-pass filter used in normal operation is selected by the OC\_FILT bit as shown in [Table 5](#).

During the Initialization Self-Test phase, the offset cancellation circuit output value is frozen.

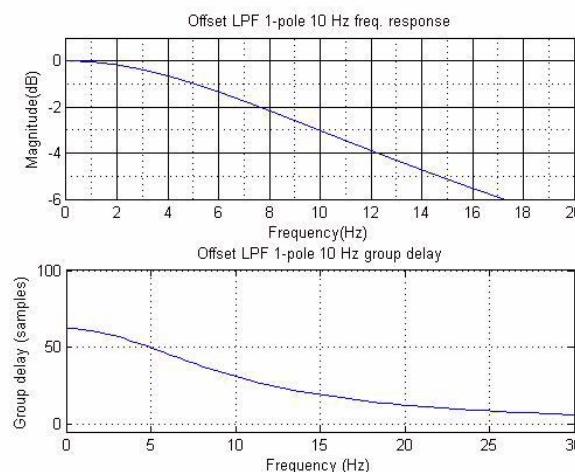
During normal operation, output rate limiting is applied to the output of the high-pass filter. Rate limiting updates the offset cancellation output by OFF<sub>Step\_xx</sub> LSB every t<sub>OffRate\_xx</sub> seconds.

**Table 5. Offset Cancellation Startup Characteristics and Timing**

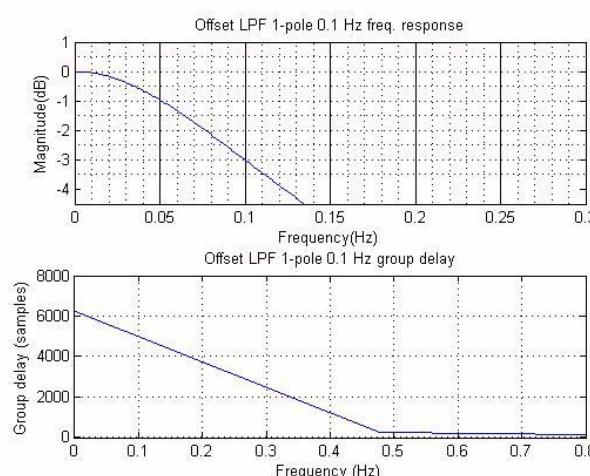
| Offset Cancellation Startup Phase | Offset LPF | Output Rate Limiting         | Total Time for Phase                           |
|-----------------------------------|------------|------------------------------|------------------------------------------------|
| 1                                 | 10 Hz      | Bypassed                     | 80 ms                                          |
| 2                                 | 0.3 Hz     | Bypassed                     | 70 ms                                          |
| Self-Test                         | 0.3 Hz     | Bypassed (Frozen during ST2) | 96 ms per Self-Test Sequence (up to 6 repeats) |
| Complete                          | 0.1 Hz     | Enabled                      | N/A                                            |

**Table 6. High-Pass Filter Coefficients**

| Description | Coefficients |                    |          |                     | Group Delay |
|-------------|--------------|--------------------|----------|---------------------|-------------|
| 10 Hz HPF   | $a_{00}$     | 0.015956938266754  |          |                     | 16.384 ms   |
|             | $n_{01}$     | 0.499998132328277  | $d_{01}$ | 1.0                 |             |
|             | $n_{02}$     | 0.499998132328277  | $d_{02}$ | -0.984043061733246  |             |
| 0.3 Hz HPF  | $a_{00}$     | 0.000482380390167  |          |                     | 537.6 ms    |
|             | $n_{01}$     | 0.499938218213271  | $d_{01}$ | 1.0                 |             |
|             | $n_{02}$     | 0.499938218213271  | $d_{02}$ | -0.999517619609833  |             |
| 0.1 Hz HPF  | $a_{00}$     | 0.0001608133316040 |          |                     | 1591ms      |
|             | $n_{01}$     | 0.4999999403953552 | $d_{01}$ | 1.0                 |             |
|             | $n_{02}$     | 0.4999999403953552 | $d_{02}$ | -0.9998391270637512 |             |



**Figure 17. 10 Hz Offset Cancellation Low-Pass Filter Characteristics**



**Figure 18. 0.1 Hz Offset Cancellation Low-Pass Filter Characteristics**

### 3.5.3.4 Offset Monitor

The device includes an offset monitor circuit. The output of the single pole low-pass filter in the offset cancellation block is continuously monitored against the offset limits specified in [Section 2.4](#). An up/down counter is employed to count up if the output exceeds the limits, and to count down if the output is within the limits. The output of the counter is compared against the count limit OFFMON<sub>CNTLIMIT</sub>. If the counter exceeds the limit, the OFF\_B flag in the SC register is cleared. The counter rails once the max counter value is reached (OFFMON<sub>CNTSIZE</sub>). The offset monitor is disabled during Initialization Phase 1, Phase 2, and Phase 3.

### 3.5.3.5 Data Interpolation

The device includes 16 to 1 linear data interpolation to minimize the system sample jitter. Each result produced by the digital signal processing chain is delayed one sample time.

### 3.5.3.6 Output Scaling

The 26-bit digital output from the DSP is clipped and scaled to a 10-bit word which spans the acceleration range of the device. [Figure 19](#) shows the method used to establish the output acceleration data word from the 26-bit DSP output.

| Over Range       |     |     | Signal |     |     |     |     |     |     |     |     |     |     |                | Noise |    |    |     | Margin |    |    |  |  |
|------------------|-----|-----|--------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|----------------|-------|----|----|-----|--------|----|----|--|--|
| D25              | D24 | D23 | D22    | D21 | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 | D11            | D10   | D9 | D8 | ... | D2     | D1 | D0 |  |  |
| 10-bit Data Word |     |     | D21    | D20 | D19 | D18 | D17 | D16 | D15 | D14 | D13 | D12 |     | Using Rounding |       |    |    |     |        |    |    |  |  |

**Figure 19. 10-Bit Output Scaling Diagram**

## 3.6 Overload Response

### 3.6.1 Overload Performance

The device is designed to operate within a specified range. Acceleration beyond that range (overload) impacts the output of the sensor. Acceleration beyond the range of the device can generate a DC shift at the output of the device that is dependent upon the overload frequency and amplitude. The g-cell is overdamped, providing the optimal design for overload performance. However, the performance of the device during an overload condition is affected by many other parameters, including:

- g-cell damping
- Non-linearity
- Clipping limits
- Symmetry

Figure 20 shows the g-cell, ADC and output clipping of the device over frequency. The relevant parameters are specified in Section 2.

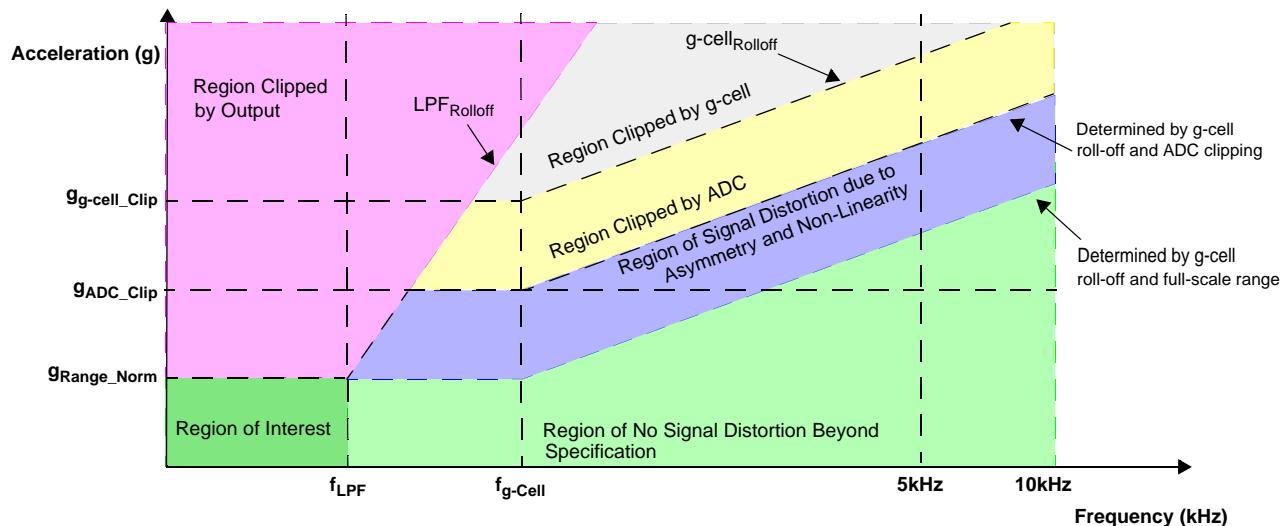


Figure 20. Output Clipping vs. Frequency

### 3.6.2 Sigma Delta Modulator Over Range Response

Over Range conditions exist when the signal level is beyond the full-scale range of the device but within the computational limits of the DSP. The  $\Sigma\Delta$  converter can saturate at levels above those specified in Section 2 ( $G_{ADC\_CLIP}$ ). The DSP operates predictably under all cases of over range, although the signal may include residual high frequency components for some time after returning to the normal range of operation due to non-linear effects of the sensor.

## 4 PSI5 Layer and Protocol

### 4.1 Communication Interface Overview

The communication interface between a master device and the MMA52xx is established via a PSI5 compatible 2-wire interface. [Figure 21](#) shows the PSI5 master to slave connections.

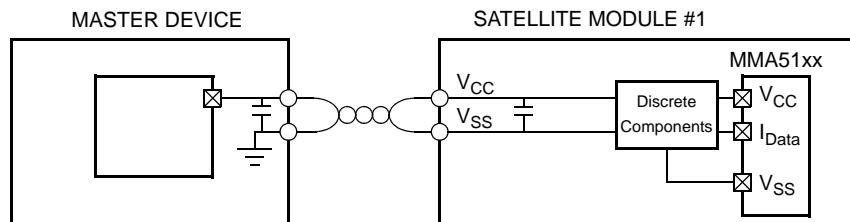


Figure 21. PSI5 Satellite Interface Diagram

### 4.2 Data Transmission Physical Layer

The device uses a two wire interface for both its power supply ( $V_{CC}$ ), and data transmission. Data transmissions from the device to the PSI5 master are accomplished via modulation of the current on the power supply line.

### 4.3 Data Transmission Data Link Layer

#### 4.3.1 Bit Encoding

The device outputs data by modulation of the  $V_{CC}$  current using Manchester 2 Encoding. Data is stored in a transition occurring in the middle of the bit time. The signal idles at the normal quiescent supply current. A logic low is defined as an increase in current at the middle of a bit time. A logic high is defined as a decrease in current at the middle of a bit time. There is always a transition in the middle of the bit time. If consecutive '1' or '0' data are transmitted, There will also be a transition at the start of a bit time.

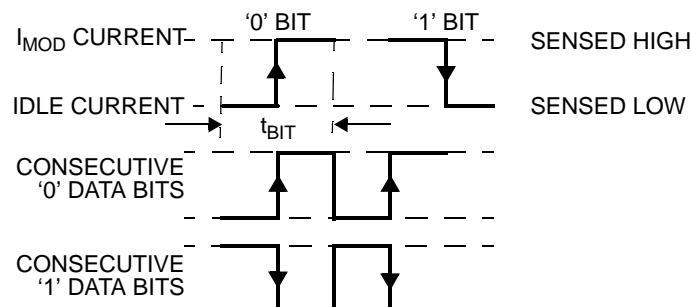


Figure 22. Manchester 2 Data Bit Encoding

#### 4.3.2 Data Transmission

Transmission frames are composed of two start bits, a 10-bit data word, and error detection bit(s). Data words are transmitted least-significant bit (LSB) first. A typical Manchester-encoded transmission frame is illustrated in Figure 23.

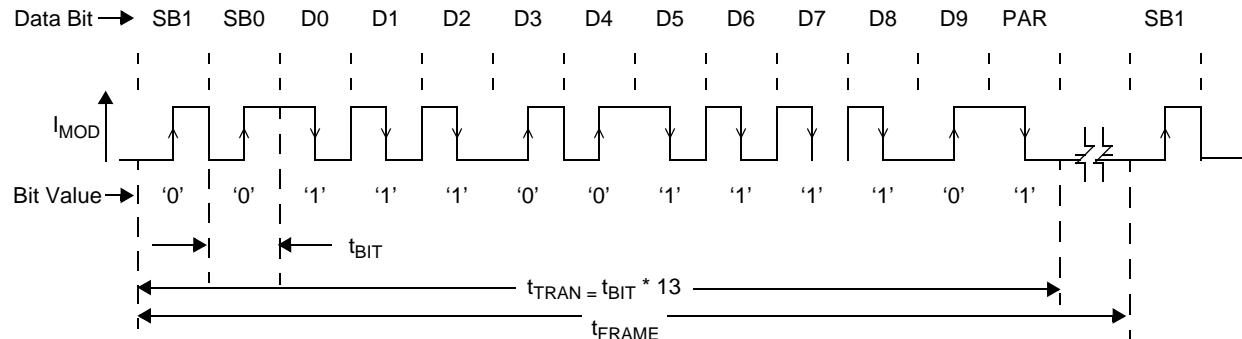


Figure 23. Example Manchester Encoded Data Transfer - PSI5-x10P

#### 4.3.3 Error Detection

Error detection of the transmitted data is accomplished via a parity bit. Even parity is employed. The number of logic "1" bits in the transmitted message must be an even number.

#### 4.3.4 Data Range Values

Table 8 shows the details for each data range.

**Table 7. PSI5 Data Values**

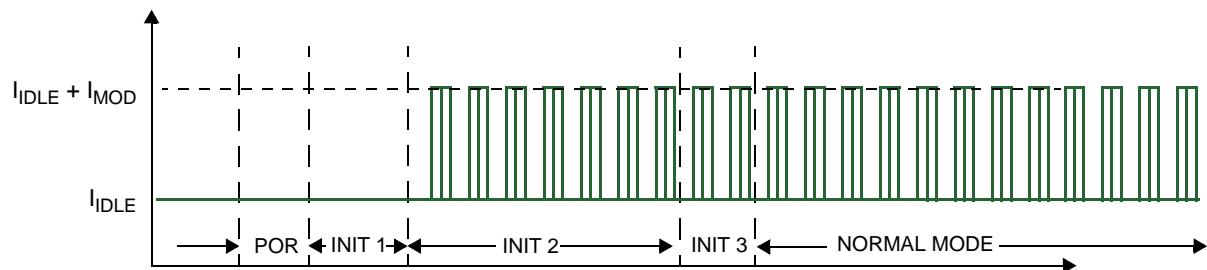
| 10-Bit Data Value |       | Description                                                                      |
|-------------------|-------|----------------------------------------------------------------------------------|
| Decimal           | Hex   |                                                                                  |
| +511              | \$1FF | Reserved                                                                         |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| +502              | \$1F6 |                                                                                  |
| +501              | \$1F5 |                                                                                  |
| +500              | \$1F4 | Sensor Defect Error Message                                                      |
| +499              | \$1F3 | Reserved                                                                         |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| +489              | \$1E9 |                                                                                  |
| +488              | \$1E8 | Sensor Busy                                                                      |
| +487              | \$1E7 | Sensor Ready                                                                     |
| +486              | \$1E6 | Sensor Ready, but Unlocked                                                       |
| +485              | \$1E5 | Reserved                                                                         |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| +481              | \$1E1 |                                                                                  |
| +480              | \$1E0 | Maximum positive acceleration value                                              |
| •                 | •     | Positive acceleration values                                                     |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| +3                | \$03  |                                                                                  |
| +2                | \$02  |                                                                                  |
| +1                | \$01  |                                                                                  |
| 0                 | 0     | 0g level                                                                         |
| -1                | \$3FF | Negative acceleration values                                                     |
| -2                | \$3FE |                                                                                  |
| -3                | \$3FD |                                                                                  |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| -480              | \$220 | Maximum negative acceleration value                                              |
| -481              | \$21F | Initialization Data Codes<br>10-Bit Status Data Nibble 1 - 16 (0000 - 1111) (Dx) |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| -496              | \$210 |                                                                                  |
| -497              | \$20F |                                                                                  |
| •                 | •     |                                                                                  |
| •                 | •     |                                                                                  |
| -512              | \$200 |                                                                                  |
|                   |       | Initialization Data IDs<br>Block ID 1 - 16 (10-bit Mode) (IDx)                   |

## 4.4 Initialization

Following powerup, the device proceeds through an initialization process which is divided into 3 phases:

- Initialization Phase 1: No Data transmissions occur
- Initialization Phase 2: Sensor self-test and transmission of configuration information
- Initialization Phase 3: Transmission of “Sensor Busy”, and “Sensor Ready” / “Sensor Defect” message

Once initialization is completed the device begins normal mode operation, which continues as long as the supply voltage remains within the specified limits.

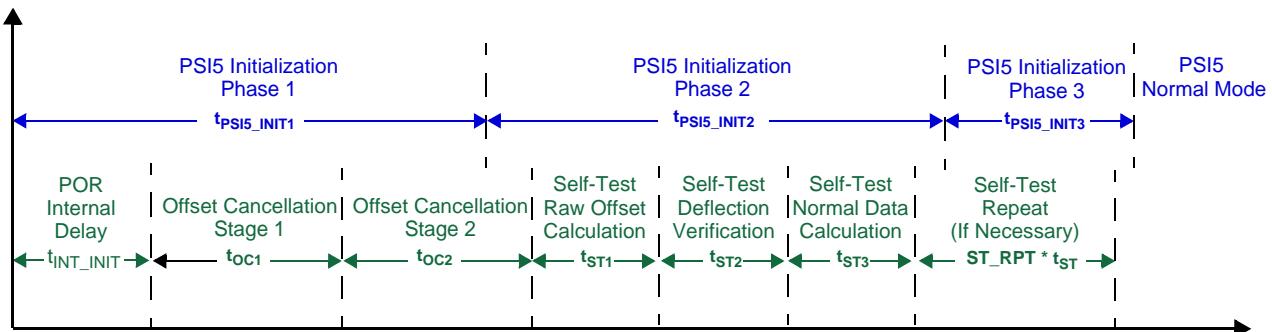


**Figure 24. PSI5 Sensor 10-Bit Initialization**

During PSI5 initialization, the device completes an internal initialization process consisting of the following:

- Power-on Reset
- Device Initialization
- Program Mode Entry Verification
- Offset Cancellation Initialization (2 Stages)
- Self-Test

Figure 25 shows the timing for internal and external initialization.



**Figure 25. Initialization Timing**

#### 4.4.1 PSI5 Initialization Phase 1

During PSI5 initialization phase 1, the device begins internal initialization and self checks, but transmits no data. Initialization begins with the sequence below and shown in [Figure 25](#):

- Internal Delay to ensure analog circuitry has stabilized ( $t_{INT\_INIT}$ )
- Offset Cancellation phase 1 Initialization ( $t_{OC1}$ )
- Offset Cancellation phase 2 Initialization ( $t_{OC2}$ )

#### 4.4.2 PSI5 Initialization Phase 2

During PSI5 initialization phase 2, the device continues its internal self checks and transmits the PSI5 initialization phase 2 data. Initialization is transmitted using the initialization data codes and IDs specified in [Table 9](#), and in the order shown in [Figure 26](#).

| D1               |                 |                  |                 |     |                  | D2              |                  |                 |                  |                 |     | ...              | D32             |     |                   |                  |                   |                  |     |                   |                  |
|------------------|-----------------|------------------|-----------------|-----|------------------|-----------------|------------------|-----------------|------------------|-----------------|-----|------------------|-----------------|-----|-------------------|------------------|-------------------|------------------|-----|-------------------|------------------|
| ID1 <sub>1</sub> | D1 <sub>1</sub> | ID1 <sub>2</sub> | D1 <sub>2</sub> | ... | ID1 <sub>k</sub> | D1 <sub>k</sub> | ID2 <sub>1</sub> | D2 <sub>1</sub> | ID2 <sub>2</sub> | D2 <sub>2</sub> | ... | ID2 <sub>k</sub> | D2 <sub>k</sub> | ... | ID32 <sub>1</sub> | D32 <sub>1</sub> | ID32 <sub>2</sub> | D32 <sub>2</sub> | ... | ID32 <sub>k</sub> | D32 <sub>k</sub> |
| Repeat k times   |                 |                  |                 |     |                  | Repeat k times  |                  |                 |                  |                 |     | ...              | Repeat k times  |     |                   |                  |                   |                  |     |                   |                  |

**Figure 26. PSI5 Initialization Phase 2 Data Transmission Order (10-bit Mode)**

The Initialization phase 2 time is calculated with the following equation:

$$t_{PHASE2} = \text{TRANS}_{\text{NIBBLE}} \times k \times (\text{DataFields}) \times t_{\text{ASYNC}}$$

where:

- $\text{TRANS}_{\text{NIBBLE}}$  = # of Transmissions per Data Nibble  
2 for 10-bit Data: 1 for ID, and 1 for Data
- $k$  = the repetition rate for the data fields
- Data Fields = 32 data fields for 10-bit data
- $t_{S-S}$  = Sync Pulse Period

#### 4.4.2.1 PSI5 Initialization Phase 2

In PSI5 initialization phase 2, 10-bit mode, the device transmits a sequence of sensor specific configuration and serial number information. The transmission data is in conformance with the PSI5 specification, Revision 1.3, Revision 1.10. The data content and transmission format is shown in [Table 8](#) and [Table 9](#). Times are calculated using the equation in [Section 4.4.2](#).

**Table 8. Initialization Phase 2 Time**

| Operating Mode             | Repetition Rate (k) | # of Transmissions | Nominal Phase 2 Time |
|----------------------------|---------------------|--------------------|----------------------|
| Asynchronous Mode (228 µs) | 8                   | 512                | 116.7 ms             |

**Table 9. PSI5 Initialization Phase 2 Data**

| PSI5 V1.2 Field ID # | PSI5 V1.2 Nibble ID # | Page Address | PSI5 Nibble Address | Register Address                                        | Description                         | Value     |
|----------------------|-----------------------|--------------|---------------------|---------------------------------------------------------|-------------------------------------|-----------|
| F1                   | D1                    | 0            | 0000                | Hard-coded                                              | Protocol Revision = V1.3            | 0100      |
| F2                   | D2, D3                |              | 0001, 0010          | Hard-coded                                              | Number of Data Blocks = 32          | 0010 0000 |
| F3                   | D4, D5                |              | 0100, 0110          | MFG_ID[7:0]                                             | Manufacturer ID                     | 0100 0110 |
| F4                   | D6, D7                |              | 0101, 0110          | Hard-coded                                              | Sensor Type = Acceleration (high-g) | 0000 0001 |
| F5                   | D8                    |              | 0111                | Factory Programmed                                      | Axis                                | 0000      |
|                      | D9                    |              | 1000                | ±60g: 0111<br>±120g: 1000<br>±240g: 1001<br>±480g: 1010 | Range                               | Varies    |
| F6                   | D10                   |              | 1001                | DEVCFG2[7:4]                                            | Sensor Specific Information         | 0000      |
|                      | D11                   |              | 1010                | DEVCFG2[3:0]                                            | Sensor Specific Information         | 0000      |
| F7                   | D12                   |              | 1011                | Hard-coded                                              | Product Revision                    | Factory   |
|                      | D13                   |              | 1100                | Hard-coded                                              | Product Revision                    | Factory   |
|                      | D14                   |              | 1101                | DEVCFG6[3:0]                                            | Product Revision                    | 0000      |
| F8                   | D15                   |              | 1110                | Factory Programmed                                      |                                     |           |
|                      | D16                   |              | 1111                | 0001                                                    |                                     |           |
|                      | D17                   |              | 0000                | 0010                                                    |                                     |           |
|                      | D18                   |              | 0001                | 0000                                                    |                                     |           |
| F9                   | D19                   | 1            | 0010                | SN0 (High Nibble)                                       | MMA52xx Serial Number               | Factory   |
|                      | D20                   |              | 0011                | SN0 (Low Nibble)                                        | MMA52xx Serial Number               | Factory   |
|                      | D21                   |              | 0100                | SN1 (High Nibble)                                       | MMA52xx Serial Number               | Factory   |
|                      | D22                   |              | 0101                | SN1 (Low Nibble)                                        | MMA52xx Serial Number               | Factory   |
|                      | D23                   |              | 0110                | SN2 (High Nibble)                                       | MMA52xx Serial Number               | Factory   |
|                      | D24                   |              | 0111                | SN2 (Low Nibble)                                        | MMA52xx Serial Number               | Factory   |
|                      | D25                   |              | 1000                | SN3 (High Nibble)                                       | MMA52xx Serial Number               | Factory   |
|                      | D26                   |              | 1001                | SN3 (Low Nibble)                                        | MMA52xx Serial Number               | Factory   |
|                      | D27                   |              | 1010                | Factory Programmed                                      |                                     |           |
|                      | D28                   |              | 1011                | 0000                                                    |                                     |           |
|                      | D29                   |              | 1100                | 0000                                                    |                                     |           |
|                      | D30                   |              | 1101                | 0000                                                    |                                     |           |
|                      | D31                   |              | 1110                | 0000                                                    |                                     |           |
|                      | D32                   |              | 1111                | 0000                                                    |                                     |           |

#### 4.4.3 Internal Self-Test

During PSI5 Initialization Phase 2 and Phase 3, the device completes its internal self-test as described below and shown in Figure 25.

- Self-Test Phase 1 - Raw Offset Calculation
  - The average offset is calculated for  $t_{ST1}$  (Self-Test Disabled).
- Self-Test Phase 2 - Self-Test Deflection Verification
  - The offset cancellation value is frozen for  $t_{ST2} + 2\text{ms}$
  - Self-Test is enabled
  - After  $t_{ST2}/2$ , the acceleration output value is averaged for  $t_{ST2}/2$  to determine the self-test value
  - The self-test value is compared against the limits specified in [Section 2.5](#)
  - Self-Test is disabled
- Self-Test Phase 3 - Self-Test Normal Data Calculation
  - The average offset is calculated for  $t_{ST3}$
  - If Self-Test passed, the device advances to normal mode
  - If Self-Test failed, the device repeats Self-Test Phases 1 through 3 up to ST\_RPT times.

#### 4.4.4 Initialization Phase 3

During PSI5 initialization phase 3, the device completes its internal self checks, and transmits a combination of “Sensor Busy”, “Sensor Ready”, or “Sensor Defect” messages as defined in [Table 7](#). Self-Test is repeated on failure up to ST\_RPT times to provide immunity to misuse inputs during initialization. Self-Test terminates successfully after one successful self-test sequence.

[Table 10](#) shows the nominal Initialization Phase 3 times for self-test repeats. Times are calculated using the following equation.

$$t_{PSI5INIT3} = \text{ROUNDUP}\left(\frac{(t_{INTINIT} + t_{OC1} + t_{OC2} + (t_{ST1} + t_{ST2} + t_{ST3}) \times (\text{STRPT} + 1)) - (t_{PSI5INIT1} + t_{PSI5INIT2xx}) + 2}{t_{ASYNC}}\right) \times t_{ASYNC}$$

**Table 10. Initialization Phase 3 Time**

| Operating Mode                                  | Self-Test Repetitions | # of Sensor Busy Messages | # of Sensor Ready or Sensor Defect Messages | Nominal Phase 3 Time (ms) |
|-------------------------------------------------|-----------------------|---------------------------|---------------------------------------------|---------------------------|
| 10-Bit Asynchronous Mode 0 (228 $\mu\text{s}$ ) | 0                     | 2                         | 2                                           | 0.91                      |
|                                                 | 1                     | 423                       |                                             | 96.90                     |
|                                                 | 2                     | 844                       |                                             | 192.89                    |
|                                                 | 3                     | 1265                      |                                             | 288.88                    |
|                                                 | 4                     | 1686                      |                                             | 384.86                    |
|                                                 | 5                     | 2107                      |                                             | 480.85                    |

### 4.5 Error Handling

#### 4.5.1 Sensor Defect Message

The following failures will cause the device to transmit a “Sensor Defect” error message:

| Error Condition             | Error Type                                                                  |
|-----------------------------|-----------------------------------------------------------------------------|
| Offset Error                | Temporary (Normal transmissions continue once offset returns within limits) |
| Self-Test Failure           | Latched until reset                                                         |
| IDEN_B, IDEF_B flag cleared | Latched until reset                                                         |

#### 4.5.2 No Response Error

The following failures will cause the device to stop transmitting:

| Error Condition                   | Error Type                                                                         |
|-----------------------------------|------------------------------------------------------------------------------------|
| Undervoltage Failure ( $V_{CC}$ ) | Temporary: Normal transmissions continue once voltage returns above failure limit) |

## 5 Package

### 5.1 Case Outline Drawing

Reference Freescale Case Outline Drawing # 98ASA00090D

[http://www.freescale.com/files/shared/doc/package\\_info/98ASA00090D.pdf](http://www.freescale.com/files/shared/doc/package_info/98ASA00090D.pdf)

### 5.2 Recommended Footprint

Reference Freescale Application Note AN3111, latest revision:

[http://www.freescale.com/files/sensors/doc/app\\_note/AN3111.pdf](http://www.freescale.com/files/sensors/doc/app_note/AN3111.pdf)

**Table 11. Revision History**

| Revision number | Revision date | Description of changes                                           |
|-----------------|---------------|------------------------------------------------------------------|
| 0               | 09/2012       | <ul style="list-style-type: none"><li>Initial release.</li></ul> |

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